# **ISONIC 2010**

Portable Ultrasonic Phased Array Flaw Detector and Recorder



Operating Manual Revision 1.10

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Covered by the United States patents 5524627, 5952577, 6545681; other US & foreign patents pending



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# **EC Declaration of Conformity**

Council Directive 89/336/EEC on Electromagnetic Compatibility, as amended by Council Directive 92/31/EEC & Council Directive 93/68/EEC Council Directive 73/23/EEC ( Low Voltage Directive ), as amended by Council Directive 93/68/EEC

We, **Sonotron NDT Ltd.**, 4 Pekeris Street, Rehovot, 76702 Israel, certify that the product described is in conformity with the Directives 73/23/EEC and 89/336/EEC as amended

### **ISONIC 2010**

Portable Digital Phased Array Ultrasonic Flaw Detector and Recorder 32 channels phased array electronics and 1 independent channel for connection of conventional and TOFD probes

The product identified above complies with the requirements of above EU directives by meeting the following standards:

### Safety

EN 61010-1:1993

### **EMC**

EN 61326:1997

EN 61000-3-2:1995 /A1:1998 /A2:1998 /A14:2000

EN 61000-3-3:1995











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## **Declaration of Compliance**

We, **Sonotron NDT Ltd.**, 4 Pekeris Street, Rehovot, 76702 Israel certify that the product described is in conformity with National and International Codes as amended

### **ISONIC 2010**

Portable Digital Phased Array Ultrasonic Flaw Detector and Recorder
32 channels phased array electronics and 1 independent channel for connection of
conventional and TOFD probes

The product identified above complies with the requirements of following National and International Codes:

- ASME Section I Rules for Construction of Power Boilers
- ASME Section VIII, Division 1 Rules for Construction of Pressure Vessels
- ASME Section VIII, Division 2 Rules for Construction of Pressure Vessels. Alternative Rules
- ASME Section VIII Article KE-3 Examination of Welds and Acceptance Criteria
- ASME Code Case 2235 Rev 9 Use of Ultrasonic Examination in Lieu of Radiography
- ASME Code Case 2541 Use of Manual Phased Array Ultrasonic Examination Section
- ASME Code Case 2557 Use of Manual Phased Array S-Scan Ultrasonic Examination Per Article 4 Section V
- ASME Code Case 2558 Use of Manual Phased Array E-Scan Ultrasonic Examination Per Article 4 Section V
- Non-Destructive Examination of Welded Joints Ultrasonic Examination of Welded Joints. – British and European Standard BS EN 1714:1998
- Non-Destructive Examination of Welds Ultrasonic Examination Characterization of Indications in Welds. – British and European Standard BS EN 1713:1998
- Calibration and Setting-Up of the Ultrasonic Time of Flight Diffraction (TOFD)
   Technique for the Detection, Location and Sizing of Flaws. British Standard BS 7706:1993
- WI 00121377, Welding Use Of Time-Of-Flight Diffraction Technique (TOFD) For Testing Of Welds. – European Committee for Standardization – Document # CEN/TC 121/SC 5/WG 2 N 146, issued Feb, 12, 2003
- ASTM E 2373 04 Standard Practice for Use of the Ultrasonic Time of Flight iffraction (TOFD) Technique
- Non-Destructive Testing Ultrasonic Examination Part 5: Characterization and Sizing of Discontinuities. – British and European Standard BS EN 583-5:2001
- Non-Destructive Testing Ultrasonic Examination Part 2: Sensitivity and Range Setting. – British and European Standard BS EN 583-2:2001
- Manufacture and Testing of Pressure Vessels. Non-Destructive Testing of Welded Joints. Minimum Requirement for Non-Destructive Testing Methods – Appendix 1 to AD-Merkblatt HP5/3 (Germany). – Edition July 1989







### **FCC Rules**

This **ISONIC 2010** ultrasonic phased array flaw detector and data recorder (hereinafter called **ISONIC 2010**) has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna
- Increase the separation between the equipment and receiver
- · Connect the equipment into an outlet on a circuit different from that to which the receiver is connected
- Consult the dealer or an experienced radio/TV technician for help

### Safety Regulations



Please read this section carefully and observe the regulations in order to ensure your safety and operate the system as intended

Please observe the warnings and notes printed in this manual and on the unit

The **ISONIC 2010** has been built and tested according to the regulations specified in EN60950/VDE0805. It was in perfect working condition on leaving the manufacturer's premises

In order to retain this standard and to avoid any risk in operating the equipment, the user must make sure to comply with any hints and warnings included in this manual

Depending on the power supply the ISONIC 2010 complies with protection class I /protective grounding/, protection class II, or protection class III

### Exemption from statutory liability for accidents

The manufacturer shall be exempt from statutory liability for accidents in the case of non-observance of the safety regulations by any operating person

### Limitation of Liability

The manufacturer shall assume no warranty during the warranty period if the equipment is operated without observing the safety regulations. In any such case, manufacturer shall be exempt from statutory liability for accidents resulting from any operation

### **Exemption from warranty**

The manufacturer shall be exempt from any warranty obligations in case of the non-observance of the safety regulations. The manufacturer will only warrant safety, reliability, and performance of the **ISONIC 2010** if the following safety regulations are closely observed:

- Setting up, expansions, re-adjustments, alterations, and repairs must only be carried out by persons who have been authorized by manufacturer
- · The electric installations of the room where the equipment is to be set up must be in accordance with IEC requirements
- The equipment must be operated in accordance with the instructions
- Any expansions to the equipment must comply with the legal requirements, as well as with the specifications for the unit concerned
- Confirm the rated voltage of your **ISONIC 2010** matches the voltage of your power outlet
- The mains socket must be located close to the system and must be easily accessible
- Use only the power cord furnished with your ISONIC 2010 and a properly grounded outlet /only protection class I/
- Do not connect the ISONIC 2010 to power bar supplying already other devices. Do not use an extension power cord
- Any interruption to the PE conductor, either internally or externally, or removing the earthed conductor will make the system unsafe
  to use /only protection class I/
- Any required cable connectors must be screwed to or hooked into the casing
- The equipment must be disconnected from mains before opening
- To interrupt power supply, simply disconnect from the mains
- Any balancing, maintenance, or repair may only be carried out by manufacturer authorized specialists who are familiar with the inherent dangers
- · Both the version and the rated current of any replacement fuse must comply with specifications laid down
- Using any repaired fuses, or short-circuiting the safety holder is illegal
- If the equipment has suffered visible damage or if it has stopped working, it must be assumed that it can no longer be operated without any danger. In these cases, the system must be switched off and be safeguarded against accidental use
- Only use the cables supplied by manufacturer or shielded data cable with shielded connectors at either end
- Do not drop small objects, such as paper clips, into the ISONIC 2010
- Do not put the ISONIC 2010 in direct sunlight, near a heater, or near water. Leave space around the ISONIC 2010
- Disconnect the power cord whenever a thunderstorm is nearby. Leaving the power cord connected may damage the ISONIC 2010
  or your property
- When positioning the equipment, external monitor, external keyboard, and external mouse take into account any local or national regulations relating to ergonomic requirements. For example, you should ensure that little or no ambient light is reflected off the external monitor screen as glare, and that the external keyboard is placed in a comfortable position for typing

- . Do not allow any cables, particularly power cords, to trail across the floor, where they can be snagged by people walking past
- The voltage of the External DC Power Supply below 11 V is not allowed for the ISONIC 2010 unit
- The voltage of the External DC Power Supply above 16 V is not allowed for the ISONIC 2010 unit
- Charge of the battery for the ISONIC 2010 unit is allowed only with use of the AC/DC converters / chargers supplied along with it or authorized by Sonotron NDT

### Remember this before:

- balancing
- carrying out maintenance work
- repairing
- exchanging any parts

Please make sure batteries, rechargeable batteries, or a power supply with SELV output supplies power

### Software (SW)

**ISONIC 2010** is a SW controlled inspection device. Based on present state of the art, SW can never be completely free of faults. **ISONIC 2010** should therefore be checked before and after use in order to ensure that the necessary functions operate perfectly in the envisaged combination. If you have any questions about solving problems related to use the **ISONIC 2010**, please contact your local Sonotron NDT representative

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# 1. Introduction

**ISONIC 2010** uniquely combines phased array, conventional UT, and TOFD modalities providing 100% raw data recording and imaging. Along with superior portability, lightweight, and battery operation this makes it suitable for all kinds of every-day ultrasonic inspections

Phased array modality is performed by powerful 32:32 phased array electronics with independently adjustable emitting and receiving aperture, each may consist of 1 through 32 elements. Groups of phased array probe elements composing emitting and receiving aperture may be fully or partially matching or totally separated allowing flexible managing of incidence angles, focal distances, types of radiated and received waves including directly reflected and diffracted mode converted signals

Each channel is equipped with it's own A/D converter. Parallel firing, A/D conversion, and "on-the-fly" digital phasing are provided for every possible composition and size of the emitting and receiving aperture. Thus implementation of each focal law is completed within single pulsing/receiving cycle providing maximal possible inspection speed

**ISONIC 2010** is additionally equipped with independent channel for conventional UT and TOFD inspection and recording capable for both single and dual modes of pulsing/receiving

High ultrasonic performance is achieved through firing phased array, TOFD, and conventional probes with bipolar square wave initial pulse with wide-range-tunable duration and amplitude. Maximal amplitude of bipolar square wave initial pulse is 300 V pp for phased array and 400 V pp for conventional channel. High stability of the amplitude and shape of the initial pulse, boosting of all it's leading and falling edges, and electronic damping are provided by the special circuit significantly improving signal to noise ratio and resolution. Thus analogue gain for each modality is controllable over 0...100 dB range

640X480 pixels 6.5" bright touch screen provides optimal resolution / power consumption rate for the outdoor operation

ISONIC 2010 is fully compliant with the following codes

- ASME Code Case 2541 Use of Manual Phased Array Ultrasonic Examination Section V
- ASME Code Case 2557 Use of Manual Phased Array S-Scan Ultrasonic Examination Section V per Article 4 Section V
- ASME Code Case 2558 Use of Manual Phased Array E-Scan Ultrasonic Examination Section V per Article 4 Section V
- ASTM 1961– 06 Standard Practice for Mechanized Ultrasonic Testing of Girth Welds Using Zonal Discrimination with Focused Search Units
- ASME Section I Rules for Construction of Power Boilers
- ASME Section VIII, Division 1 Rules for Construction of Pressure Vessels
- ASME Section VIII, Division 2 Rules for Construction of Pressure Vessels. Alternative Rules
- ASME Section VIII Article KE-3 Examination of Welds and Acceptance Criteria
- ASME Code Case 2235 Rev 9 Use of Ultrasonic Examination in Lieu of Radiography
- Non-Destructive Examination of Welded Joints Ultrasonic Examination of Welded Joints. –
   British and European Standard BS EN 1714:1998
- Non-Destructive Examination of Welds Ultrasonic Examination Characterization of Indications in Welds. – British and European Standard BS EN 1713:1998
- Calibration and Setting-Up of the Ultrasonic Time of Flight Diffraction (TOFD) Technique for the Detection, Location and Sizing of Flaws. – British Standard BS 7706:1993
- WI 00121377, Welding Use Of Time-Of-Flight Diffraction Technique (TOFD) For Testing Of Welds. – European Committee for Standardization – Document # CEN/TC 121/SC 5/WG 2 N 146, issued Feb, 12, 2003
- ASTM E 2373 04 Standard Practice for Use of the Ultrasonic Time of Flight Diffraction (TOFD) Technique
- Non-Destructive Testing Ultrasonic Examination Part 5: Characterization and Sizing of Discontinuities. – British and European Standard BS EN 583-5:2001
- Non-Destructive Testing Ultrasonic Examination Part 2: Sensitivity and Range Setting. British and European Standard BS EN 583-2:2001
- Manufacture and Testing of Pressure Vessels. Non-Destructive Testing of Welded Joints.
   Minimum Requirement for Non-Destructive Testing Methods Appendix 1 to AD-Merkblatt HP5/3 (Germany).— Edition July 1989

# 2. Technical Data

**Phased Array** 

Number of Channels: 32

Pulse Type: Bipolar Square Wave with electronically controlled damping Initial Transition:  $\leq$ 7.5 ns (10-90% for rising edges / 90-10% for falling edges) Smoothly tunable (12 levels) 50V ... 300 V pp into 50  $\Omega$ 

Half Wave Pulse Duration: 50...600 ns controllable in 10 ns step

Probe Types: Linear / Ring Array

Emitting aperture: 1...32

Excitation: Parallel for every possible emitting aperture

Phasing (emitting aperture): 0...100 µs with 5 ns resolution

Receiving Aperture: 1...32

Gain: 0...100 dB controllable in 0.5 dB resolution

Advanced Low Noise Design: 85 µV peak to peak input referred to 80 dB gain / 25 MHz

bandwidth

Frequency Band: 0.2 ... 25 MHz Wide Band

A/D Conversion: 100 MHz 16 bit – parallel for every possible receiving aperture,

no multiplexing involved

Superimposing of receiving On-the-fly – parallel for every possible receiving aperture, no

aperture signals: multiplexing involved

Phasing (receiving aperture): On-the-fly 0...100 µs with 5 ns resolution

A-Scan Display Modes: RF, Rectified (Full Wave / Negative or Positive Half Wave)

DAC / TCG per focal law - for Theoretical - dB/mm (dB/")

rectified and RF display: Experimental – through recording echoes from several

reflectors

46 dB Dynamic Range, Slope ≤ 20 dB/□s, Capacity ≤ 40 points

Gates per focal law: 2 Independent Gates / unlimitedly expandable

Gate Start and Width: Controllable over whole variety of A-Scan Display Delay and A-

Scan Range

in 0.1 mm /// 0.001" resolution

Gate Threshold: 5...95 % of A-Scan height controllable in 1 % resolution

Number of focal laws: 8192

Scanning and Imaging: B-Scan (E-Scan) – regular and True-To-Geometry

Sector Scan (S-Scan) - regular and True-To-Geometry

One-probe multi-group image composed from several B- and S-

**Scans** 

Top (C-Scan), Side, End View imaging formed through encoded /

time-based line scanning, 3D-Viewer

Method of data storage: 100% raw data capturing

**Conventional UT and TOFD** 

Number of Channels:

Pulse Type: Bipolar Square Wave with electronically controlled damping Initial Transition: ≤7.5 ns (10-90% for rising edges / 90-10% for falling edges) Pulse Amplitude: Smoothly tunable (12 levels) 50V ... 400 V pp into 50  $\Omega$ 

Half Wave Pulse Duration: 50...600 ns independently controllable in 10 ns step

Modes: Single / Dual

Gain: 0...100 dB controllable in 0.5 dB resolution

Advanced Low Noise Design:  $85 \mu V$  peak to peak input referred to 80 dB gain / 25 MHz

bandwidth

Frequency Band: 0.2 ... 25 MHz Wide Band

A/D Conversion: 100 MHz 16 bit

Digital Filter: 32-Taps FIR band pass with controllable lower and upper

frequency limits

A-Scan Display Modes: RF, Rectified (Full Wave / Negative or Positive Half Wave),

Signal's Spectrum (FFT Graph)

DAC / TCG - for rectified and RF Theoretical - dB/mm (dB/")

display:

Gates:

Graphs):

Experimental – through recording echoes from several

reflectors

46 dB Dynamic Range, Slope ≤ 20 dB/μs, Capacity ≤ 40 points DGS: Standard Library for 18 probes / unlimitedly expandable

2 Independent Gates / unlimitedly expandable

Gate Start and Width: Controllable over whole variety of A-Scan Display Delay and A-

Scan Range

in 0.1 mm /// 0.001" resolution

Gate Threshold: 5...95 % of A-Scan height controllable in 1 % resolution

Measuring Functions - Digital 27 automatic functions / expandable; Dual Ultrasound Velocity Display Readout: Measurement Mode for Multi-Layer Structures; Curved Surface /

Thickness / Skip correction for angle beam probes; Ultrasound velocity and Probe Delay Auto-Calibration for all types of probes Freeze All - A-Scans and Spectrum Graphs / Freeze Peak - A-Scans / All measurements functions, manipulating Gates, and

±6dB Gain varying are available for frozen signals

Scanning and Imaging: Thickness Profile B-Scan, Cross-sectional B-Scan, Plane View

CB-Scan. TOFD

Standard Length of one Line

Freeze (A-Scans and Spectrum

Scanning record:

50...20000 mm (2"...800"), automatic scrolling

Method of data storage: 100% raw data capturing General

PRF: 10...5000 Hz controllable in 1 Hz resolution

On-Board Computer CPU: AMD LX 800 - 500MHz

RAM: 1 Gigabyte Internal Flash Memory - Quasi 4 Gigabytes

HDD:

Screen: Sun readable 6.5" touch screen 640 × 480

Controls: Sealed keyboard and mouse

Interface: 2 × USB, Ethernet

Operating System: Windows™XP Embedded Encoder interface: Incremental TTL encoder

Standard Length of one Line 50...20000 mm (2"...800"), automatic scrolling

Scanning record:

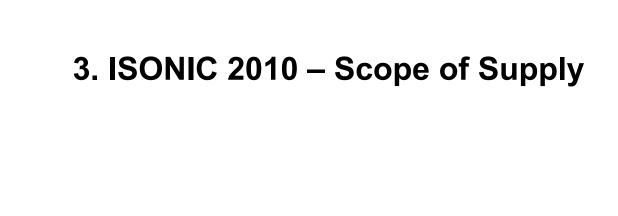
Housing: IP 53 rugged aluminum case with carrying handle

Dimensions: 265×156×101 mm (10.43"×6.14"×3.98") - without battery

265×156×139 mm (10.43"×6.14"×5.47") - with battery

Weight: 2.500 kg (5.50 lbs) - without battery

3.430 kg (7.55 lbs) - with battery



#	Item	Order Code (Part #)	Note
1	ISONIC 2010 – Portable Digital Phased Array Ultrasonic Flaw Detector and Recorder: 32 channels PA electronics and 1 independent channel for connection of conventional and	SA 804900	Standard Configuration # 1
	TOFD probes		
	ISONIC 2010 Electronic unit – including:  Internal PC (AMD LX 800 500 MHz, RAM-1G, Quazi-HDD Flash Memory Card 4G, Windows XP Embedded, Large 8.5" active TFT sVGA LCD High Color Sun-Readable Touch Screen, Built-In Interfaces: 2XUSB; Ethernet; PS/2; Front Panel Sealed Keyboard and Mouse; sVGA output)		
	> 100 250 VAC AC/DC converter > SE 254064 PA - 64-Channel PA Pulsing Receiving and Processing Card:  Up to 300 Volt Peak to Peak Bipolar Square Wave – Tunable Width / Tunable Firing Level Pulser; Special Probe Protection Circuit to Prevent Probe Damage for Not Properly Adjusted Pulse Width; Freely Adjustable		
	Emitting Aperture - up to 64 elements simultaneous firing  Analogue Gain: 0100 dB controllable in 0.5 dB resolution;		
	Analogue Gain: 0100 dB controllable in 0.5 dB resolution; Advanced Low Noise Design: 81μV peak to peak input referred to 80 dB gain / 25 MHz bandwidth; Frequency Band: 0.2 25 MHz Wide Band / 32-Taps FIR band pass digital filter with controllable lower and upper frequency limits; Freely Adjustable Receiving Aperture - up to 64 Elements, Parallel Analog to Digital Conversion - No Multiplexing Involved - For Any Size of Receiving Aperture  Built-In Incremental Encoder Interface		
	> SE 254016/1 - 1-Channel UDS 3-6 Pulser Receiver Card		
	☐ Up to 400 V Peak to Peak Bipolar Square Wave – Tunable Width / Tunable Firing Level Pulser; Single / Dual Modes of Operation; Special Probe Protection Circuit to Prevent Probe Damage for Not Properly		
	Adjusted Pulse Width  Gain: 0100 dB controllable in 0.5 dB resolution; Advanced Low  Noise Design: 81µV peak to peak input referred to 80 dB gain / 25 MHz  bandwidth; Frequency Band: 0.2 25 MHz Wide Band / 32-Taps FIR  band pass digital filter with controllable lower and upper frequency limits  Built-In Incremental Encoder Interface		
	Software     ISONIC 2010 Multi-Functional Package (SWA 99C10200)		
	● PA Modality		
	♦ PA Probes Database		
	Unlimitedly expandable database of PA probes - total aperture size, pitch and offset, wedge geometry and US Velocity / delay geometry and US Velocity, etc		
	⇒ Exporting of PA probes / wedges / delays database into a file		
	◆ A-Scan  ⇒ Manual control of emitting/receiving aperture, incidence angle, type of ultrasonic wave, focal distance / focal depth, etc  ⇒ A-Scan (Full Wave / Neg Wave / Pos Wave rectification; RF)  ⇒ True-To-Geometry Ray Trace (Focal Law) Visualization		
	⇒ DAC, TCG     ⇒ Smart Automatic Measurements of Gated Signals - Flank / Flank     First / Top / Top First; Auto-Marking Measuring Points on A-Scan     ⇒ Enhanced Signal Evaluation for Live and Frozen A-Scans including		
	Gain Adjustments whilst in Freeze Mode		
	⇔ Generating Comprehensive Setup and A-Scan report     Cross-Sectional Scanning and Imaging:		
	◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)		
	⇒ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of <b>True-To-Geometry B-Scan</b> image with 100% raw data capturing		
	⇒ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:		
	inequality of PA probe elements		
	● variety of wedge losses  ◆ Sector-Scan (S-Scan as per ASME Case 2557)		
	<ul> <li>Sector-Scan (S-Scan as per ASME Case 2557)</li> <li>⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of regular Sector</li> </ul>		
	Scan (S-Scan) or True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing		

#	Item	Order Code (Part #)	Note
-+	⇒ Angle Gain Compensation: Unique Individual Gain per Incidence	\·\* /	
	Angle / Gain per Focal Law Adjustment compensating incidence		
	angle-steering caused varieties of:  ■ transparency for probe - material boundary		
	wedge losses		
	effective size of emitting/receiving aperture		
	Both above modes of electronically controlled cross sectional scanning and imaging		
	are featured with:		
	<ul> <li>⇒ Freeze / Unfreeze of live image</li> <li>⇒ Live A-Scan for the selected beam of live / frozen image, smart</li> </ul>		
	signal evaluation using conventional gating of ultrasonic signals		
	⇒ Versatile user configurable color palette for defects imaging, DAC		
	normalization, reject threshold, noise suppression, etc		
	⇒ Zoom In / Out		
	⇒ Automatic coupling monitoring / inspection for laminations             whilst using wedged linear array probes – optionally activated /		
	deactivated by operator		
	⇒ Storing raw data image along with complete sequence of recorded		
	A-Scans into a file		
	⇒ Upload raw data image from file ⇒ Off-line image evaluation including:		
	► Sizing of defects – coordinates and projection size - gate based		
	and image based		
	► Play-back and evaluation of A-Scans sourcing the image		
	Echo-dynamic pattern analysis		
	Defects outlining and pattern recognition based on A-Scan sequence analysis		
	Off-line reconstruction of the images for various Gain / Reject		
	level		
	▶ DAC normalization		
	⇔ Generating Comprehensive Setup and Scanning Report		
	Three-Dimensional Top - Side - End View Imaging Through Linear		
	Scanning with PA Probes:		
	♦ ABI-Scan based C-Scan and 3D Data Presentation		
	♦ Sector-Scan based C-Scan and 3D Data Presentation		
	⇒ Electromechanically encoded or time-based line scanning with PA probe		
	⇒ 3D presentation - Top, Side, End View		
	⇒ Amplitude / Distance mode of C-Scan - Top View image		
	⇒ Thickness Profiling / Flaw Detection presentation of Side / End View		
	⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated /		
	deactivated by operator		
	⇒ Storing raw 3D data comprising all raw data B-Scans each		
	accompanied with complete sequence of recorded raw data A-Scans into		
	a file  ⇒ Upload 3D data from a file		
	⇒ Comprehensive off-line analysis / postprocessing of 3D data featured		
	with:		
	▶ 3D-Viewer		
	Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans		
	Echo Dynamic Pattern Analysis;		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based</li> </ul>		
	and image based		
	► Gate Manipulation - Rebuild Top, Side, End views for various		
	Gate Settings  ► Off-line reconstruction of Top, Side, End views for various Gain /		
	Reject level		
	▶ DAC normalization		
	Slicing and Filtering Images		
	<ul> <li>▶ Statistical Analysis</li> <li>⇒ Generating Comprehensive Setup and Scanning Report</li> </ul>		
	Conventional UT Modality - Single Channel Operation		
	◆ A-Scan		
	→ A-Scan ⇒ A-Scan (Full Wave / Neg Wave / Pos Wave rectification; RF)		
	⇒ Selectable A-Scan color scheme		
	⇒ DAC, DGS, TCG		
	⇒ Auto Calibration for Straight Beam and Angle Beam Probes		
	⇒ Curved Surface / Wall Thickness / Skip - Correction for Angle Beam		
	Inspection  Smart Automatic Measurements of Cated Signals - Flank / Flank		
	⇒ Smart Automatic Measurements of Gated Signals - Flank / Flank First / Top / Top First; Auto-Marking Measuring Points on A-Scan		
	⇒ FFT (Frequency Domain Signal Presentation) - additional feature for		
	defects evaluation and / or pattern recognition / probes characterization		
	⇒ Enhanced Signal Evaluation for Live and Frozen A-Scans including  Gain Adjustments whilst in Freeze Mode		
	Gain Adjustments whilst in Freeze Mode		I

#	Item	Order Code (Part #)	Note
	Dual Ultrasound Velocity Multi-echo Measurements Mode  Generating Comprehensive Setup and A-Scan / FFT graph report  Pulse Echo Inspection, Recording, and Imaging Through Linear  Scanning with Conventional Probes:  ↑ Thickness Profile Imaging and Recording (Typical  Application: Corrosion characterization)  ⇔ Continuous measuring of thickness value along probe trace and composing of Thickness Profile B-Scan with 100% raw data capturing  ♦ B-Scan cross-sectional imaging and recording of defects for longitudinal and shear wave inspection  ⇔ Continuous measuring of echo amplitudes and reflectors coordinates along probe trace and composing of True-To-Geometry B-Scan with 100% raw data capturing  ♦ CB-Scan horizontal plane-view imaging and recording of defects for shear, surface, and guided wave inspection  ⇔ Continuous measuring of echo amplitudes and reflectors coordinates along probe trace and composing of True-To-Geometry CB-Scan with 100% raw data capturing  All above modes of linear scanning and imaging are featured with:  ⇒ Electromechanically encoded or time-based data recording  ⇔ Recording of complete sequence of A-Scans along scanning line  ⇔ Off-line evaluation of images featured with:  ▶ Sizing of defects at any location along stored image – coordinates and projection size (plus remaining thickness, thickness loss, and length of damage for Thickness B-Scan);  ▶ Play-back and evaluation of A-Scans  ▶ Echo dynamic pattern analysis  ▶ Off-line reconstruction of image for various Gain / Gate setup  ⇔ Generating Comprehensive Setup and Scanning Report  Time of Flight Diffraction Technology - TOFD:  ♦ TOFD Inspection – RF B-Scan and D-Scan Imaging  ⇔ Electromechanically encoded or time-based data recording  ⇔ Averaging recorded A-Scans  ⇔ Recording of complete sequence of A-Scans  ⇔ Reco		
	<ul> <li>USB Flash Drive for External Data Storage</li> <li>12 months warranty period for the instrument</li> </ul>		
2	Lifetime free SW update  Deepargookle Patton Ni MH 0 AH / 12\/	SK 2005102	Optional
3	Rechargeable Battery Ni MH 9 AH / 12V  Battery Charger	SK 2005102 SK 2005103	Optional
3	•		Required for battery charge
4	Silicon Rubber Jacket    Compare Lowers Lowers   Compare   Compare	SK 2010111	Optional
5	Travel Hard Case	SK 2005104	Optional Allows safe cargo transportation

#	Item	Order Code	Note
"	item	(Part #)	11010
6	Postprocessing SW Package for Office PC: ISONIC PA PP  ⇒ comprehensive postprocessing of inspection results files captured by ISONIC 2009 UPA-Scope and ISONIC 2010 - PA Modality using Inspection SW Packages of any type  ⇒ automatic creating of inspection reports	SWA 909844	Included into scope of supply of each ISONIC 2010 instrument
7	Wheels-Free Compact One-Axis Mechanical Encoder for manual line scanning with PA probes and for TOFD / CHIME/ CB-Scan / Thickness Profile / Straight Beam B-Scan imaging with conventional probes	SK 2001108 PA	Optional
8	Inspection SW Utility for ISONIC 2010 - PA Modality: Kls - Delta	SWA 910801	Optional
	Technique  ⇒ Single probe insonification of defects with receiving and evaluation of direct and mode converted echoes for the distinguishing between volumetric and sharp defects  ⇒ Generating Comprehensive Setup and Evaluation Report		
9	Inspection SW Package for ISONIC 2010 - PA Modality: Horizontal	SWA 910803	Optional
	Plane Top View CB-Scan - Lateral Scanning  Scanning Technique # 1  ⇒ Electronically controlled scanning using predefined pulsing / receiving aperture and type of ultrasonic wave provided through swiveling of ultrasonic beam with predefined incidence angle and automatic real time composing of Top View CB-Scan image with 100% raw data capturing  ⇒ Swiveling Angle Gain Compensation: Unique Individual Gain per Swiveling Angle / Gain per Focal Law Adjustment compensating swiveling angle-steering caused varieties of:		
	<ul><li>wedge losses</li><li>effective size of emitting/receiving aperture</li></ul>		
	Scanning Technique # 2  ⇒ Electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence and swiveling angle, and type of ultrasonic wave through linear motion of ultrasonic beam within entire probe and automatic real time composing of Top View CB-Scan image with 100% raw data capturing  ⇒ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  ● inequality of PA probe elements  Both electronically controlled scanning techniques are featured with:  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image from file  ⇒ Off-line image evaluation including:  ▶ Sizing of defects — coordinates and projection size - gate based and image based  ▶ Play-back and evaluation of A-Scans sourcing the image  ▶ Echo-dynamic pattern analysis  ▶ Defects outlining and pattern recognition based on A-Scan sequence analysis  ▶ Off-line reconstruction of the images for various Gain / Reject level  ▶ DAC normalization  ⇔ Generating Comprehensive Setup and Scanning Report		
10	Inspection SW Package for ISONIC 2010 - PA Modality: EXPERT - Weld Inspection (planar and circumferential butt welds, nozzle welds, fillet welds)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Weld and Parent Material with True- To-Location Visualization of Defects and Weld Geometry:  ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to	SWA 910804	Optional
	compensate:  ■ inequality of PA probe elements  ■ variety of wedge losses  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ◆ Sector-Scan (S-Scan as per ASME Case 2557)		

#	Item	Order Code	Note
	⇒ Angular electronically controlled scanning using predefined pulsing / receiving	(Part #)	
	aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of <b>True-To-Geometry Sector-Scan (S-Scan)</b> image		
	with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain		
	per Focal Law Adjustment compensating incidence angle-steering caused varieties of:		
	transparency for probe - material boundary		
	• wedge losses		
	<ul> <li>effective size of emitting/receiving aperture</li> <li>Both modes of electronically controlled cross sectional scanning are featured with:</li> </ul>		
	⇒ Freeze / Unfreeze of live image		
	⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation		
	using conventional gating of ultrasonic signals		
	⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc		
	⇒ Automatic coupling monitoring / inspection for laminations whilst using		
	wedged linear array probes – optionally activated / deactivated by operator		
	⇒ Zoom In / Out		
	⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file		
	⇒ Upload raw data image from file		
	→ Off-line image evaluation including:		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based  ▶ Play-back and evaluation of A-Scans sourcing the image		
	<ul> <li>Play-back and evaluation of A-Scans sourcing the image</li> <li>Echo-dynamic pattern analysis</li> </ul>		
	Defects outlining and pattern recognition based on A-Scan sequence analysis		
	▶ Off-line reconstruction of the images for various Gain / Reject level		
	DAC normalization		
	⇒ Generating Comprehensive Setup and Scanning Report  Three-Dimensional Top - Side - End View Imaging of Weld and Heat		
	Affected Zone Through Linear Scanning with PA Probes:		
	♦ ABI-Scan based C-Scan and 3D Data Presentation		
	♦ Sector-Scan based C-Scan and 3D Data Presentation		
	⇒ Electromechanically encoded or time-based line scanning with PA probe		
	⇒ 3D presentation - Top, Side, End View		
	⇒ Amplitude / Distance mode of C-Scan - Top View image		
	⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator		
	⇒ Storing raw 3D data comprising all raw data B-Scans each accompanied with		
	complete sequence of recorded raw data A-Scans into a file		
	⇒ Upload 3D data from a file		
	⇒ Comprehensive off-line analysis / postprocessing of 3D data featured with:		
	<ul> <li>3D-Viewer</li> <li>Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans</li> </ul>		
	Echo Dynamic Pattern Analysis;		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based		
	<ul> <li>Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings</li> <li>Off-line reconstruction of Top, Side, End views for various Gain / Reject level</li> </ul>		
	DAC normalization		
	➤ Slicing and Filtering Images		
	► Statistical Analysis		
4.4	⇒ Generating Comprehensive Setup and Scanning Reporting    Setup and Setup and Securing Reporting   Setup and Securing Reporting	0)4/4 040005	Ontional
11	Inspection SW Package for ISONIC 2010 - PA Modality: EXPERT CU -	SWA 910805	Optional
	Weld Inspection (longitudinal welds in tubes; nozzle, fillet, TKY,		
	etc welds for curved components)		
	Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Weld and Parent Material with True-		
	To-Location Visualization of Defects and Weld Geometry:		
	◆ Sector-Scan (S-Scan as per ASME Case 2557)		
	Angular electronically controlled scanning using predefined pulsing / receiving		
	aperture, and type of ultrasonic wave provided through steering of incidence angle and		
	automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image		
	with 100% raw data capturing		
	⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:		
	transparency for probe - material boundary		
	wedge losses		
	effective size of emitting/receiving aperture		
	⇒ Freeze / Unfreeze of live image		
	⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals		
			į .
	⇒ Versatile user configurable color palette for defects imaging, DAC normalization,		

#	Item	Order Code (Part #)	Note
	⇒ Zoom In / Out	\. <del></del>	
	⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  file		
	⇒ Upload raw data image from file		
	⇒ Off-line image evaluation including:		
	► Sizing of defects – coordinates and projection size - gate based and image		
	based  ▶ Play-back and evaluation of A-Scans sourcing the image		
	Echo-dynamic pattern analysis		
	▶ Defects outlining and pattern recognition based on A-Scan sequence analysis		
	Off-line reconstruction of the images for various Gain / Reject level		
	DAC normalization		
	⇒ Generating Comprehensive Setup and Scanning Report  Three-Dimensional Top - Side - End View Imaging of Weld and Heat		
	Affected Zone Through Linear Scanning with PA Probes:		
	♦ Sector-Scan based C-Scan and 3D Data Presentation		
	⇒ Electromechanically encoded or time-based line scanning with PA probe		
	⇒ 3D presentation - Top, Side, End View		
	⇒ Amplitude / Distance mode of C-Scan - Top View image		
	⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator		
	⇒ Storing raw 3D data comprising all raw data B-Scans each accompanied with		
	complete sequence of recorded raw data A-Scans into a file		
	⇒ Upload 3D data from a file		
	⇒ Comprehensive off-line analysis / postprocessing of 3D data featured with:		
	<ul> <li>3D-Viewer</li> <li>Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans</li> </ul>		
	Echo Dynamic Pattern Analysis;		
	► Sizing of defects – coordinates and projection size - gate based and image		
	based		
	<ul> <li>Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings</li> <li>Off-line reconstruction of Top, Side, End views for various Gain / Reject level</li> </ul>		
	DAC normalization		
	► Slicing and Filtering Images		
	► Statistical Analysis		
	⇒ Generating Comprehensive Setup and Scanning Report	014/4 0 / 0000	0
12	⇔ Generating Comprehensive Setup and Scanning Report     Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -	SWA 910806	Optional
12	⇔ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS –      Vertical Line Focusing Scanning and Imaging (typical application:	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS −      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails,	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      □ Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      □ Cross-Sectional Scanning and Imaging Uniquely Representing Real      □ Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)      with True-To-Location Visualization of Defects:      ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real     Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)      with True-To-Location Visualization of Defects:      ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)      □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:      ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)      □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS —      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:      ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)      □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data	SWA 910806	Optional
12	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real     Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)      with True-To-Location Visualization of Defects:      ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)      □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing      □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:     ● inequality of PA probe elements	SWA 910806	Optional
112	□ Generating Comprehensive Setup and Scanning Report      Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -      Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)      Cross-Sectional Scanning and Imaging Uniquely Representing Real     Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)      with True-To-Location Visualization of Defects:      ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)      □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing      □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:     ○ inequality of PA probe elements     ○ variety of wedge losses	SWA 910806	Optional
112	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  inequality of PA probe elements variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)	SWA 910806	Optional
112	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2557)  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -  Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements  □ variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  inequality of PA probe elements variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements □ variety of wedge losses □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic Visuality of PA probe elements □ variety of wedge losses □ Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate: □ inequality of PA probe elements □ variety of wedge losses □ Sector-Scan (S-Scan as per ASME Case 2557) □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Inserting Report    Inspection SW Package for ISONIC 2010 - PA Modality: VLFS −   Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)   Cross-Sectional Scanning and Imaging Uniquely Representing Real     Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)     with True-To-Location Visualization of Defects:     ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)     □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing     □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:     □ inequality of PA probe elements     □ variety of wedge losses     ◆ Sector-Scan (S-Scan as per ASME Case 2557)     □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing     □ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ Inequality of PA probe elements □ variety of wedge losses □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, incidence and per Incidence Point / Gain per Focal Law Adjustment to compensate: □ Inequality of PA probe elements □ variety of wedge losses □ Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, incidence Point / Gain per Focal Law Adjustment to compensate: □ Inequality of PA probe elements □ variety of wedge losses □ Sector-Scan (S-Scan as per ASME Case 2557) □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing □ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements  □ variety of wedge losses  Agular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic Point / Gain per Focal Law Adjustment to compensate:  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements  □ variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  □ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  □ transparency for probe - material boundary  □ wedge losses	SWA 910806	Optional
12	Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements  □ variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements  □ variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  □ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  □ transparency for probe - material boundary  □ wedge losses  □ effective size of emitting/receiving aperture	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -   Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)   Cross-Sectional Scanning and Imaging Uniquely Representing Real     Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)     with True-To-Location Visualization of Defects:     ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)     ⇒ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing     ⇒ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:     ● inequality of PA probe elements     ● variety of wedge losses     ◆ Sector-Scan (S-Scan as per ASME Case 2557)     ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing     ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:     ● transparency for probe - material boundary     ● wedge losses     ● effective size of emitting/receiving aperture	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)    Cross-Sectional Scanning and Imaging Uniquely Representing Real	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS -   Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)   Cross-Sectional Scanning and Imaging Uniquely Representing Real     Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)     with True-To-Location Visualization of Defects:     ◆ ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)     ⇒ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing     ⇒ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:     ● inequality of PA probe elements     ● variety of wedge losses     ◆ Sector-Scan (S-Scan as per ASME Case 2557)     ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing     ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:     ● transparency for probe - material boundary     ● wedge losses     ● effective size of emitting/receiving aperture	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Dunique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  New York of PA probe elements  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  Transparency for probe - material boundary  Medge losses  effective size of emitting/receiving aperture  Both modes of electronically controlled cross sectional scanning are featured with:  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization,	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  inequality of PA probe elements  variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Both modes of electronically controlled cross sectional scanning are featured with:  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  □ Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  □ Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  □ inequality of PA probe elements  □ variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  □ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  □ transparency for probe - material boundary  □ wedge losses  □ effective size of emitting/receiving aperture  Both modes of electronically controlled cross sectional scanning are featured with:  □ Freeze / Unfreeze of live image  □ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  □ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  □ Automatic coupling monitoring / inspection for laminations whilst using	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  inequality of PA probe elements  variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Both modes of electronically controlled cross sectional scanning are featured with:  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  inequality of PA probe elements  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Both modes of electronically controlled cross sectional scanning are featured with:  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  Zoom In / Out  Storing raw data image along with complete sequence of recorded A-Scans into a	SWA 910806	Optional
12	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS - Vertical Line Focusing Scanning and Imaging (typical application: inspection of planar and circumferential ER welds, welded rails, etc)  Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI) with True-To-Location Visualization of Defects:  ABI-Scan (B-Scan or E-Scan as per ASME Case 2558)  Linear electronically controlled scanning using predefined size of pulsing / receiving aperture, incidence angle, and type of ultrasonic wave within entire probe and automatic real time composing of True-To-Geometry B-Scan image with 100% raw data capturing  Unique Individual Gain per Incidence Point / Gain per Focal Law Adjustment to compensate:  inequality of PA probe elements  variety of wedge losses  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Both modes of electronically controlled cross sectional scanning are featured with:  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator	SWA 910806	Optional

	Item	Order Code (Part #)	Note
	Sizing of defects – coordinates and projection size - gate based and image	(* 5 ;	
	based  ▶ Play-back and evaluation of A-Scans sourcing the image		
	► Echo-dynamic pattern analysis		
	Defects outlining and pattern recognition based on A-Scan sequence analysis		
	<ul> <li>Off-line reconstruction of the images for various Gain / Reject level</li> <li>DAC normalization</li> </ul>		
	⇒ Generating Comprehensive Setup and Scanning Report		
	Three-Dimensional Top - Side - End View Imaging of Weld and Heat		
	Affected Zone Through Linear Scanning with PA Probes:		
	◆ ABI-Scan based C-Scan and 3D Data Presentation		
	◆ Sector-Scan based C-Scan and 3D Data Presentation		
	⇒ Electromechanically encoded or time-based line scanning with PA probe		
	<ul> <li>⇒ 3D presentation - Top, Side, End View</li> <li>⇒ Amplitude / Distance mode of C-Scan - Top View image</li> </ul>		
	wedged linear array probes - optionally activated / deactivated by operator		
	⇒ Storing raw 3D data comprising all raw data B-Scans each accompanied with		
	complete sequence of recorded raw data A-Scans into a file		
	⇒ Upload 3D data from a file		
	⇔ Comprehensive off-line analysis / postprocessing of 3D data featured with:     ▶ 3D-Viewer		
	<ul> <li>Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans</li> </ul>		
	Echo Dynamic Pattern Analysis;		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based  Cate Manipulation Rebuild Top Side End views for various Cate Settings		
	<ul> <li>Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings</li> <li>Off-line reconstruction of Top, Side, End views for various Gain / Reject level</li> </ul>		
	DAC normalization		
	► Slicing and Filtering Images		
	► Statistical Analysis		
	⇒ Generating Comprehensive Setup and Scanning Report		
- 1			
3	Inspection SW Package for ISONIC 2010 - PA Modality: VLFS CU – Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real	SWA 910807	Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:	SWA 910807	Optional
•	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)	SWA 910807	Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving	SWA 910807	Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and	SWA 910807	Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing	SWA 910807	Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  Acom In / Out  Storing raw data image along with complete sequence of recorded A-Scans into a file		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  □ Upload raw data image from file  ⇒ Off-line image evaluation including:		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  □ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  □ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  □ transparency for probe - material boundary  □ wedge losses  □ effective size of emitting/receiving aperture  □ Freeze / Unfreeze of live image  □ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  □ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  □ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  □ Zoom In / Out  □ Storing raw data image along with complete sequence of recorded A-Scans into a file  □ Upload raw data image evaluation including:  □ Off-line image evaluation including:  □ Sizing of defects – coordinates and projection size - gate based and image		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image evaluation including:  ▶ Sizing of defects – coordinates and projection size - gate based and image based  ▶ Play-back and evaluation of A-Scans sourcing the image  ▶ Echo-dynamic pattern analysis		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  Zoom In / Out  Storing raw data image along with complete sequence of recorded A-Scans into a file  Upload raw data image from file  Off-line image evaluation including:  Flay-back and evaluation of A-Scans sourcing the image  Echo-dynamic pattern analysis  Defects outlining and pattern recognition based on A-Scan sequence analysis		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  Sector-Scan (S-Scan as per ASME Case 2557)  Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  transparency for probe - material boundary  wedge losses  effective size of emitting/receiving aperture  Freeze / Unfreeze of live image  Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  Coom In / Out  Storing raw data image along with complete sequence of recorded A-Scans into a file  Upload raw data image from file  Off-line image evaluation including:  Fizing of defects – coordinates and projection size - gate based and image based  Play-back and evaluation of A-Scans sourcing the image  Echo-dynamic pattern analysis  Defects outlining and pattern recognition based on A-Scan sequence analysis  Off-line reconstruction of the images for various Gain / Reject level		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image from file  ⇒ Off-line image evaluation including:  ▶ Sizing of defects – coordinates and projection size - gate based and image based  ▶ Play-back and evaluation of A-Scans sourcing the image  ▶ Echo-dynamic pattern analysis  ▶ Defects outlining and pattern recognition based on A-Sc		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image from file  ⇒ Off-line image evaluation including:  ▶ Sizing of defects – coordinates and projection size - gate based and image based  ▶ Play-back and evaluation of A-Scans sourcing the image  ▶ Echo-dynamic pattern analysis  ▶ Defects outlining and pattern recognition based on A-Scan sequence analysis  ▶ Defects outlining and pattern recognition based on A-Scan sequence analysis  ▶ DAC normalization  Generating Comprehensive Setup and Scanning Report		Optional
	Vertical Line Focusing Scanning and Imaging of Tubular Objects (typical application: inspection of longitudinal ERW in tubes and similar objects)  Cross-Sectional Scanning and Imaging Uniquely Representing Real  Distribution Of Ultrasonic Beams In the Selected Region of Interest (ROI)  with True-To-Location Visualization of Defects:  ◆ Sector-Scan (S-Scan as per ASME Case 2557)  ⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and automatic real time composing of True-To-Geometry Sector-Scan (S-Scan) image with 100% raw data capturing  ⇒ Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain per Focal Law Adjustment compensating incidence angle-steering caused varieties of:  ● transparency for probe - material boundary  ● wedge losses  ● effective size of emitting/receiving aperture  ⇒ Freeze / Unfreeze of live image  ⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator  ⇒ Zoom In / Out  ⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image along with complete sequence of recorded A-Scans into a file  ⇒ Upload raw data image from file  ⇒ Off-line image evaluation including:  ▶ Sizing of defects – coordinates and projection size - gate based and image based  ▶ Play-back and evaluation of A-Scans sourcing the image  ▶ Echo-dynamic pattern analysis  ▶ Defects outlining and pattern recognition based on A-Sc		Optional

#	Item	Order Code	Note
	⇒ 3D presentation - Top, Side, End View	(Part #)	
	⇒ Amplitude / Distance mode of C-Scan - Top View image		
	Automatic coupling monitoring / inspection for laminations whilst using wedged linear array probes – optionally activated / deactivated by operator		
	⇒ Storing raw 3D data comprising all raw data B-Scans each accompanied with		
	complete sequence of recorded raw data A-Scans into a file		
	<ul> <li>⇒ Upload 3D data from a file</li> <li>⇒ Comprehensive off-line analysis / postprocessing of 3D data featured with:</li> </ul>		
	▶ 3D-Viewer		
	<ul> <li>Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans</li> <li>Echo Dynamic Pattern Analysis;</li> </ul>		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based  ▶ Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings		
	Off-line reconstruction of Top, Side, End views for various Gain / Reject level		
	DAC normalization		
	<ul><li>Slicing and Filtering Images</li><li>Statistical Analysis</li></ul>		
	⇔ Generating Comprehensive Setup and Scanning Report		
14	Inspection SW Utility for ISONIC 2010 - PA Modality: Multi-Group -	SWA 910810	
	Implementation of Several (up to 3) Various Insonification		
	Schemes Simultaneously with Use of Differently Configured Groups of Elements of Wedged Linear Array Probe		
	♦ Multi-Group Composer – Creating Insonification Scheme with Use of up		
	to 3 (Three) Different Sector Scan and/or ABI Scan COVERAGE files created		
	for the same probe in the following modes:  ⇒ ISONIC 2010 Multi-Functional Package (SWA 99C10200) or ISONIC 2009 UPA-		
	Scope Multi-Functional Package (SWA 99C09200) – on case of use ≤ 32 elements		
	linear arrays		
	⇒ ISONIC 2010 EXPERT Optional SW Package (SWA 910804) or ISONIC 2009 UPA-Scope EXPERT Optional SW Package (SWA 909804) – on case of use ≤ 32		
	elements linear arrays		
	⇒ ISONIC 2010 VLFS Optional SW Package (SWA 910806) or ISONIC 2009 UPA- Scope VLFS Optional SW Package (SWA 909806) – on case of use ≤ 32 elements		
	linear arrays		
	⇒ ISONIC 2010 EXPERT CU Optional SW Package (SWA 910805) or ISONIC 2009 UPA-Scope EXPERT CU Optional SW Package (SWA 909805) – on case of use ≤ 32		
	elements linear arrays		
	⇒ ISONIC 2010 VLFS CU Optional SW Package (SWA 910807) or ISONIC 2009 UPA-Scope VLFS CU Optional SW Package (SWA 909807) – on case of use ≤ 32		
	elements linear arrays		
	◆ Multi-Group Cross Sectional Inspection Implementation of Insonification According to the Scheme Created by Multi-Group Composer, for Each		
	Group Implemented and for All of Them Together it is Provided:		
	⇒ Freeze / Unfreeze of live image		
	Live A-Scan for the selected beam of live / frozen image, smart signal evaluation using conventional gating of ultrasonic signals		
	⇒ Versatile user configurable color palette for defects imaging, DAC normalization,		
	reject threshold, noise suppression, etc  ⇒ Zoom In / Out		
	⇒ Storing raw data image along with complete sequence of recorded A-Scans into a		
	file  ⇒ Upload raw data image from file		
	⇒ Off-line image evaluation including:		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image based</li> </ul>		
	▶ Play-back and evaluation of A-Scans sourcing the image		
	Echo-dynamic pattern analysis		
	<ul> <li>Defects outlining and pattern recognition based on A-Scan sequence analysis</li> <li>Off-line reconstruction of the images for various Gain / Reject level</li> </ul>		
	▶ DAC normalization		
	<ul> <li>⇒ Generating Comprehensive Setup and Scanning Report</li> <li>♦ Multi-Group Three-Dimensional Top - Side - End View Imaging Through</li> </ul>		
	Linear Scanning, for Each Group Implemented and for All of Them Together		
	it is Provided:		
	Sector Scan and/or ABI Scan based C-Scan and 3D Data Presentation  Electromechanically encoded or time-based line scanning with PA probe		
	<ul> <li>⇒ Electromechanically encoded or time-based line scanning with PA probe</li> <li>⇒ 3D presentation - Top, Side, End View</li> </ul>		
	⇒ Amplitude / Distance mode of C-Scan - Top View image		
	Storing raw 3D data comprising all raw data B-Scans each accompanied with complete sequence of recorded raw data A-Scans into a file		
	⇒ Upload 3D data from a file		
	⇔ Comprehensive off-line analysis / postprocessing of 3D data featured with:		
	▶ 3D-Viewer	I	I

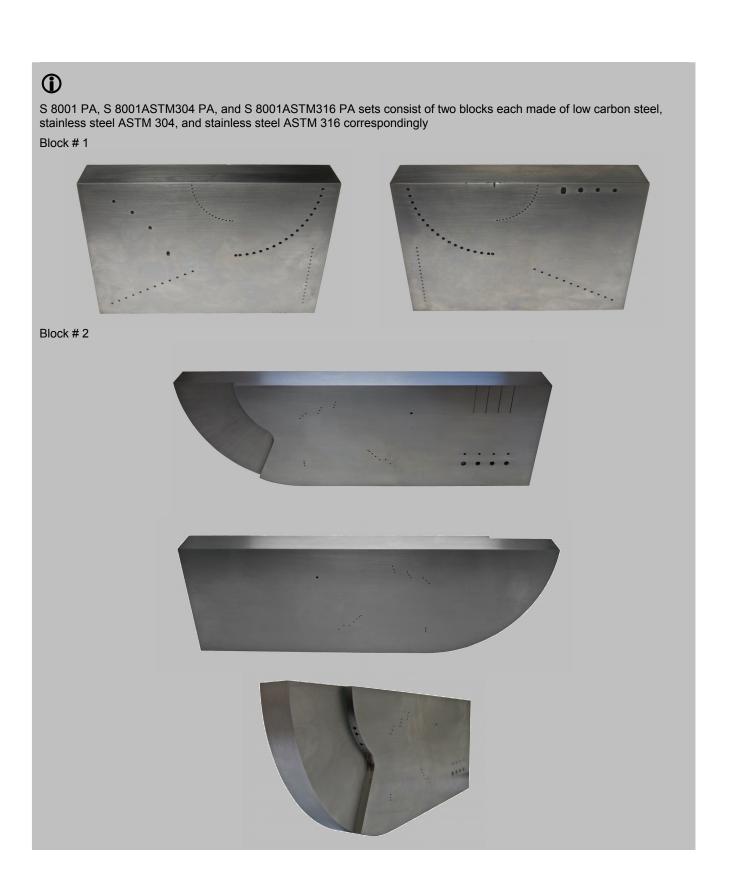
#	Item	Order Code (Part #)	Note
	Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans     Cha Dispersion Bettern Against 1999	( )	
	<ul> <li>Echo Dynamic Pattern Analysis;</li> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based  ▶ Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings		
	Off-line reconstruction of Top, Side, End views for various Gain / Reject level  Off-line reconstruction of Top, Side, End views for various Gain / Reject level		
	<ul><li>DAC normalization</li><li>Slicing and Filtering Images</li></ul>		
	Statistical Analysis		
45	⇔ Generating Comprehensive Setup and Scanning Reporting    Second   S	0)4/4 040044	
15	Inspection SW Package for ISONIC 2010 - PA Modality: RODScan - Inspection of solid and hollow shafts, axles, and the like -	SWA 910811	
	longitudinal wave sector scan insonification combined with		
	circumferential scanning and complete cross section image		
	reconstruction		
	Cross-Sectional Scanning and Imaging Uniquely Representing Real Distribution Of Ultrasonic Beams In the Solid or Hollow Rods with True-to-		
	Geometry Visualization of Defects and Rod Profile:		
	♦ Sector-Scan (S-Scan as per ASME Case 2557)		
	⇒ Angular electronically controlled scanning using predefined pulsing / receiving aperture, and type of ultrasonic wave provided through steering of incidence angle and		
	automatic real time composing of <b>True-To-Geometry Sector-Scan (S-Scan)</b> image with 100% raw data capturing		
	⇒ 2 types of Sector Scan strategy of the rod – fixed focal distance / fixed focal depth		
	Angle Gain Compensation: Unique Individual Gain per Incidence Angle / Gain		
	<ul> <li>per Focal Law Adjustment compensating incidence angle-steering caused varieties of:</li> <li>transparency for probe - material boundary</li> </ul>		
	wedge losses		
	<ul> <li>● effective size of emitting/receiving aperture</li> <li>⇒ Freeze / Unfreeze of live image</li> </ul>		
	⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation		
	using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization,		
	reject threshold, noise suppression, etc  ⇒ Zoom In / Out		
	⇒ Storing raw data image along with complete sequence of recorded A-Scans into a		
	file  ⇒ Upload raw data image from file		
	⇒ Off-line image evaluation including:		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image based</li> </ul>		
	► Play-back and evaluation of A-Scans sourcing the image		
	<ul> <li>Echo-dynamic pattern analysis</li> <li>Defects outlining and pattern recognition based on A-Scan sequence analysis</li> </ul>		
	Off-line reconstruction of the images for various Gain / Reject level		
	<ul> <li>▶ DAC normalization</li> <li>⇒ Generating Comprehensive Setup and Scanning Report</li> </ul>		
	♦ Unique Whole-Rod Cross Sectional View through Superimposing of		
	Sector-Scan Images Obtained through Encoded / Time Based Circumferential Scanning with Linear Array Probe		
	⇒ Versatile user configurable color palette for defects imaging, DAC normalization,		
	reject threshold, noise suppression, etc  ⇒ Zoom In / Out		
	Storing raw data image along with complete sequence of recorded A-Scans into a file		
	⇔ Upload raw data image from file		
	<ul> <li>Off-line image evaluation including:</li> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based		
	<ul> <li>Play-back and evaluation of A-Scans sourcing the image</li> <li>Echo-dynamic pattern analysis</li> </ul>		
	▶ Defects outlining and pattern recognition based on A-Scan sequence analysis		
	<ul> <li>Off-line reconstruction of the images for various Gain / Reject level</li> <li>DAC normalization</li> </ul>		
	⇒ Generating Comprehensive Setup and Scanning Report	014/4 6 (22 (2	
16	Inspection SW Package for ISONIC 2010 - PA Modality: RADIUS-Scan	SWA 910812	
	<ul> <li>Inspection of corner areas of various parts made of composites, metals, etc using linear array probes equipped with specially</li> </ul>		
	designed wedges contoured according to inner corner surface		
	Cross-Sectional Scanning and Imaging Uniquely Representing Real		
1	Distribution Of Ultrasonic Beams In the Corner-Shaped Profile:		ı l

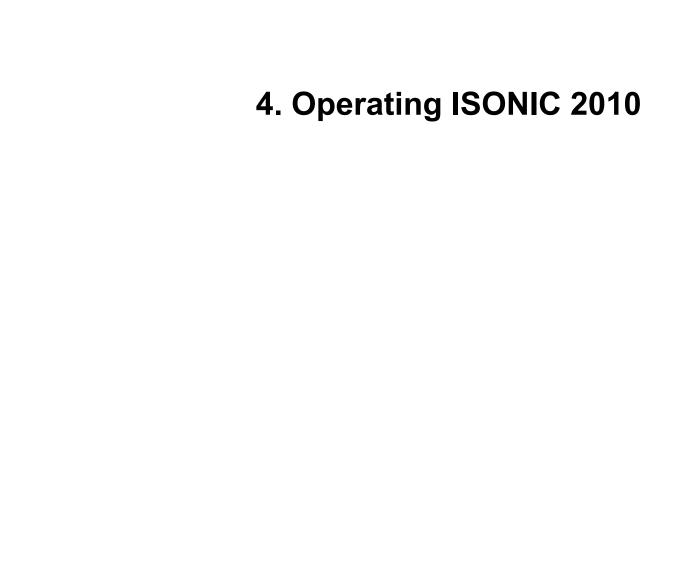
#	Item	Order Code (Part #)	Note
	♦ True-to-Geometry Corner B-Scan	(ι ωιιπ)	
	<ul> <li>⇒ Combined angular / linear electronically controlled scanning using floating pulsing / receiving aperture providing guiding of ultrasonic beam along inner surface of cornered profile with 0-degree hitting at every excitation point and automatic real time composing of True-To-Geometry Corner B-Scan image with 100% raw data capturing</li> <li>⇒ Gain Per Shot Compensation: Unique Individual Gain per Incidence per focal law adjustment compensating varieties of:</li> <li>● wedge losses</li> </ul>		
	effective size of emitting/receiving aperture		
	<ul> <li>● efficiency of excitation</li> <li>⇒ Freeze / Unfreeze of live image</li> <li>⇒ Live A-Scan for the selected beam of live / frozen image, smart signal evaluation</li> </ul>		
	using conventional gating of ultrasonic signals  ⇒ Versatile user configurable color palette for defects imaging, DAC normalization, reject threshold, noise suppression, etc  ⇒ Zoom In / Out		
	⇒ Storing raw data image along with complete sequence of recorded A-Scans into a file		
	⇒ Upload raw data image from file     ⇒ Off-line image evaluation including:		
	➤ Sizing of defects – coordinates and projection size - gate based and image		
	based  ▶ Play-back and evaluation of A-Scans sourcing the image		
	► Echo-dynamic pattern analysis		
	<ul> <li>Defects outlining and pattern recognition based on A-Scan sequence analysis</li> <li>Off-line reconstruction of the images for various Gain / Reject level</li> <li>DAC normalization</li> </ul>		
	⇔ Generating Comprehensive Setup and Scanning Report  Three Bissessional Ten. Side Food View Inspire of Compared Bouton		
	Three-Dimensional Top - Side - End View Imaging of Cornered Parts Through Linear Scanning with PA Probes:		
	◆ Corner B-Scan based C-Scan and 3D Data Presentation		
	<ul> <li>⇒ Electromechanically encoded or time-based line scanning with PA probe</li> <li>⇒ 3D presentation - Top, Side, End View</li> </ul>		
	⇒ Amplitude / Distance mode of C-Scan - Top View image		
	Storing raw 3D data comprising all raw data B-Scans each accompanied with complete sequence of recorded raw data A-Scans into a file		
	□ Upload 3D data from a file		
	Off-line Recovery and Play-Back of A-Scans and Raw Data B-Scans		
	<ul> <li>Echo Dynamic Pattern Analysis;</li> <li>Sizing of defects – coordinates and projection size - gate based and image</li> </ul>		
	based		
	<ul> <li>Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings</li> <li>Off-line reconstruction of Top, Side, End views for various Gain / Reject level</li> </ul>		
	► DAC normalization		
	<ul> <li>Slicing and Filtering Images</li> <li>Statistical Analysis</li> </ul>		
	⇒ Generating Comprehensive Setup and Scanning Report		
17	Postprocessing SW Package for Office PC: ISONIC PA PP –	SWA909844	Delivered with every ISONIC 2010 instrument
	⇔ comprehensive postprocessing of inspection results files captured by ISONIC 2009  UPA-Scope and ISONIC 2010 - PA Modality using Inspection SW Packages of any type      automatic creating of inspection reports		
18	Postprocessing SW Package for Office PC: ISONIC PA ABIScan	SWA 909845	Option
	Puzzle  ⇒ composing PUZZLE file comprising raw data from several ABIScan based top view		
	scanning files providing large area coverage with/without overlap  ⇒ comprehensive off-line analysis / postprocessing of 3D PUZZLE data featured with:		
	► Top, Side, End Puzzle Composed Views of Large Area		
	3D-Viewer     Off-line Recovery and Play-Back of A-Scans		
	Echo Dynamic Pattern Analysis;		
	<ul> <li>Sizing of defects – coordinates and projection size - gate based and image based</li> <li>Gate Manipulation - Rebuild Top, Side, End views for various Gate Settings</li> </ul>		
	Off-line reconstruction of Top, Side, End views for various Gain / Reject level		
	<ul> <li>DAC normalization</li> <li>Slicing and Filtering Images</li> </ul>		
	► Statistical Analysis		
10	⇒ generating comprehensive Setup and Scanning Report	222222224442	Ontional
19	Postprocessing SW Package for Office PC: IOFFICE - ISONIC Office	SWA99C0203	Optional
	⇒ comprehensive postprocessing of inspection results files captured by ISONIC 2001, ISONIC 2005, ISONIC 2006, ISONIC 2007, ISONIC 2008, ISONIC 2009 UPA-Scope, ISONIC 2010 instruments using conventional and TOFD probes and Inspection SW Packages of any type		
L	⇒ generating comprehensive inspection reports in MS Word® format		

#	Item	Order Code	Note
20	Dual Channel TOFD preamplifier package including:  ⇒ Dual Channel TOFD preamplifier  ⇒ Set of 2 low noise coaxial cables (10 meters length each) for connection to the signal input of ISONIC instrument	(Part #) SA 80442	Optional Improves long cable connection to conventional and TOFD ultrasonic probes
21	ISONIC Alarmer - standard firmware configuration and hardware platform including:  ⇒ Internal Speaker functioning according to alarm logic settings of conventional channel(s) in ISONIC 2005, 2006, 2007, 2008, 2009 UPA-Scope, 2010 instruments  ⇒ Speaker Volume Control Wheel  ⇒ Headphone Connector  ⇒ 25-pin programmable Input / Output interface (blank)  ⇒ USB port and cable for connecting to the instrument	SE 554780987	Optional
22	Set of test blocks for phased array inspection; material - low carbon steel	S 8001 PA	See photos below
23	Set of test blocks for phased array inspection; material - stainless steel ASTM 304	S 8001ASTM304 PA	See photos below
24	Set of test blocks for phased array inspection; material - stainless steel ASTM 316	S 8001ASTM316 PA	See photos below
25	Ultrasonic PA, conventional, and TOFD probes, fixtures, scanners, cables and other accessories depending on the inspection tasks to be resolved		Optional



Information about typical PA probes, wedges, delay lines is available in the chapters 5.3.1, 5.4, 5.5.2.5 of this Operating Manual





Please read the following information before you use **ISONIC 2010**. It is essential to read and understand the following information so that no errors occur during operation, which could lead damaging of the unit or misinterpretation of inspection results

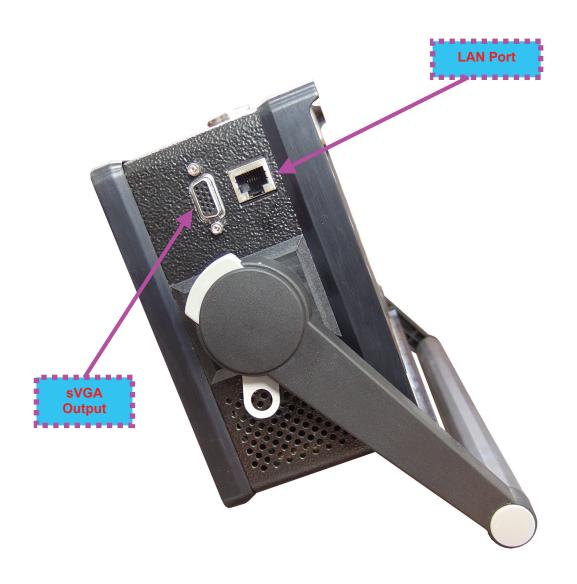
# 4.1. Preconditions for ultrasonic testing with ISONIC 2010

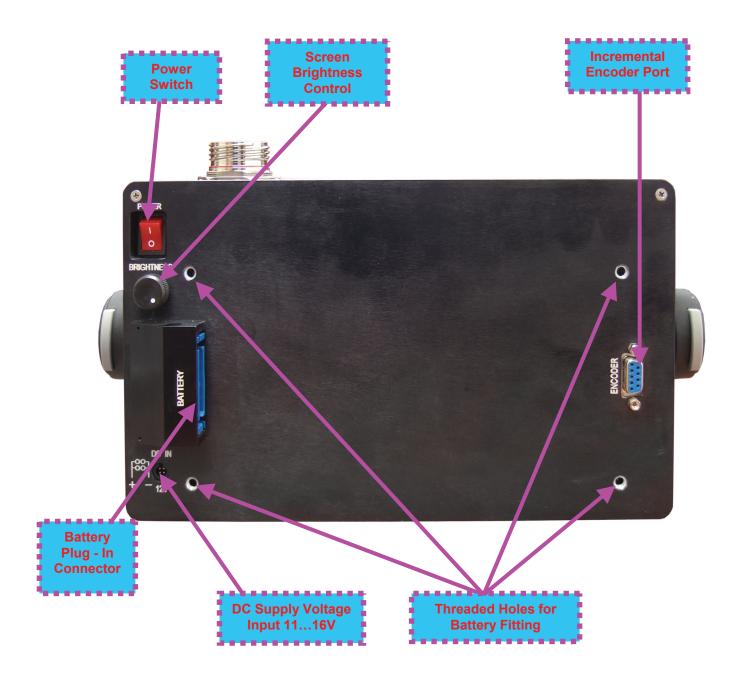
Operator of ISONIC 2010 must be certified as at least Level 2 Ultrasonic Examiner additionally having the adequate knowledge of

- · operating digital ultrasonic flaw detector
- basics of computer operating in the **Windows™** environment including turning computer on/off, keyboard, touch screen and mouse, starting programs, saving and opening files

# 4.2. ISONIC 2010 Controls and Terminals







# 4.3. Turning On / Off

ISONIC 2010 may be powered from:

- 100...250 VAC through external AC/DC converter
- External 11...16V DC source (12V typical)
- Rechargeable battery (optionally)

### **AC Power Supply**

- □ Ensure that power switch is in **O** position before connecting power cords
- □ Connect one end of AC power cord to AC/DC converter and plug another end into AC mains
- □ Connect DC power cord with suppression filter outgoing from AC/DC converter to DC Supply Voltage Input of **ISONIC 2010**

### **External DC Power Supply**

- ☐ Ensure DC mains do supply voltage between 11 V and 16 V
- □ Ensure that power switch is in **O** position before connecting power cord
- □ Connect one end of DC power cord with suppression filter to DC Supply Voltage Input of ISONIC 2010 and plug another end into DC mains

### **Battery**

- □ Ensure that power switch is in **O** position
- Plug in battery and fix it using 4 screws

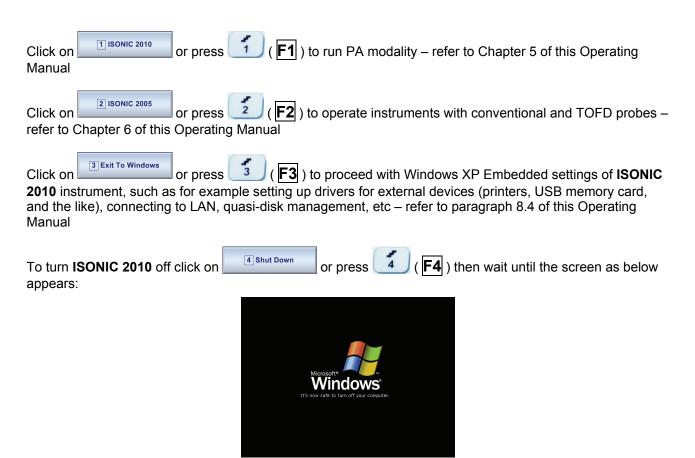
### Power-Up and Turn Off

To Power-Up **ISONIC 2010** set power switch into position. An automatic system test program will then be executed; during this test various texts and information appear followed by the screen as below while booting up



Wait until ISONIC 2010 Start Screen becomes active automatically upon boot up is completed





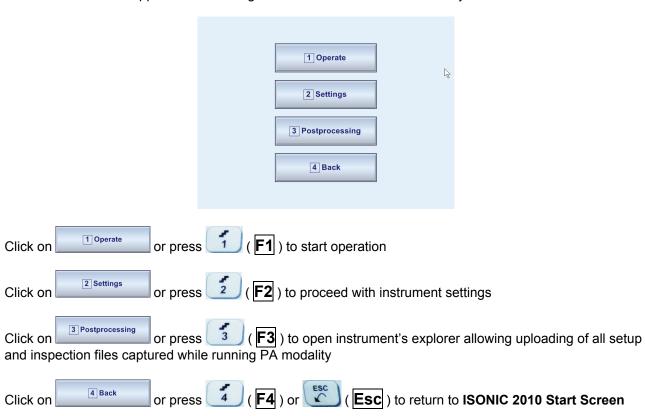
Set power switch into **O** position upon

After turning ISONIC 2010 OFF wait at least 10...30 seconds before switching it ON again

# **5. PA Modality**

# 5.1. PA Modality Start Menu

The screen as below appears on selecting to run ISONIC 2010 in PA modality



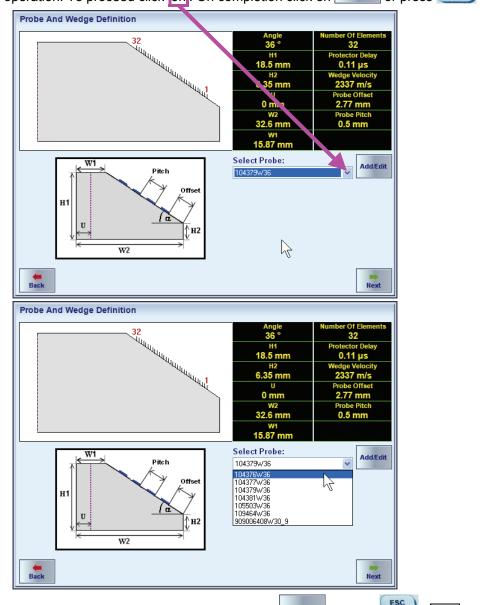
# 5.2. Standard and Optional Modes Of Operation

1 Operate The following screen appears upon clicking on in the PA modality start menu as per paragraph 5.1 of this Operating Manual): 1 Wedge 2 Delay Line 3 Options R 4 Back (F1) to run PA modality with use of linear array probes mounted Click on onto wedges in standard modes featuring each instrument (F2) to run PA modality with use of linear array probes mounted 2 Delay Line Click on onto straight delay lines or applied directly to the object under test in standard modes featuring each instrument or press (F3) to run PA modality with use of various PA probes (linear and 3 Options Click on matrix arrays) in combination with wedges or delay lines in accordance with optional modes, which may vary from instrument to instrument or press 4 (F4) or (Esc) to return to PA modality start menu 4 Back Click on

# 5.3. Wedged Linear Array Probes – Standard Modes of Operation

### 5.3.1. Wedged Linear Array Probes Database

It is necessary to define new wedged linear array probe or select an existing one in the instrument's database for further operation. To proceed click on. On completion click on or press



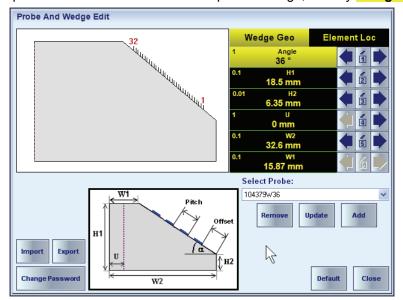
To return to the Modes of Operation Menu for PA modality click on

To enter new probe into the database of modifying data about existing mode click on Add/Edit. This operation is password protected - for the first time new password to be entered by the supervisor so the contents of the database will not be affected unexpectedly in the future

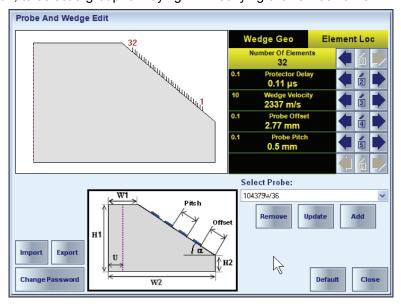
For keying in password it may be used either top panel or virtual keyboard generated on the instrument's screen



There are 2 groups of parameters to be defined for each probe / wedge, namely Wedge Geometry



and **Element Loc**ation, to select a group for keying in / modifying click on it's name



For most of the parameters their meaning is obviously clear from the sketch indicated on the instrument's screen; among them there are just two parameters requiring more explanation:

- $\Box$   $\alpha$  is designation of **Angle** (Wedge Angle)
- **U** is part of the wedge that may not be used for forming ultrasonic field in the material, for example protective metallic shield on the front surface of the wedge

To modify / key in parameter value refer to paragraph 5.3.2 of this Operating Manual

### Other controls:

- □ Export | − export probes database from instrument into a file
- □ Import of probes database into instrument from a file
- □ Change Password managing passwords for authorized access to database entries

_	– remove probe data from the database
_	– call up the factory default to start with for newly entered probe data
<b>-</b>	- add new probe's data to database (new name to be keyed in first upon clicking on that button)
3	– confirming modified data for the probe existing in the database (probe name to be confirmed)

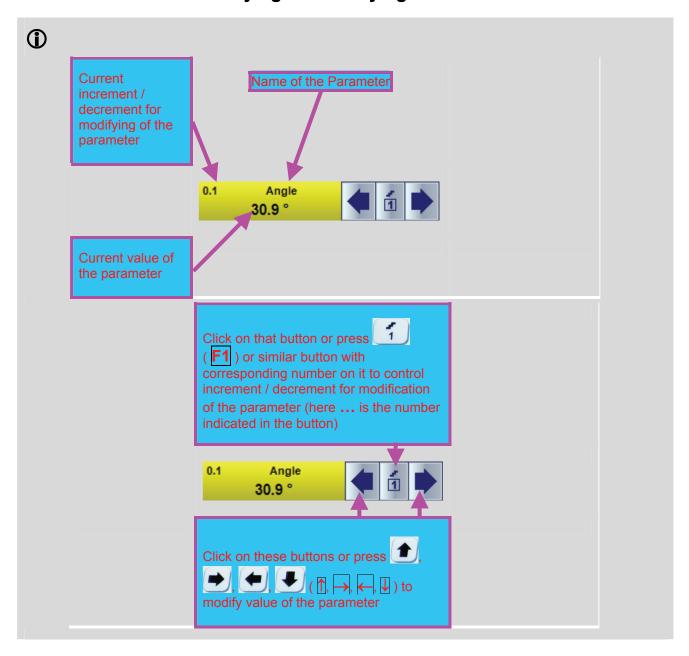
To return to previous **Probe and Wedge Definition** screen click on or press (Esc)

Typical linear array probes and corresponding wedges are listed below

#	ltem	Order Code (Part ##)	Note	
1	PA-2M8E1P - LINEAR ARRAY Frequency: 2 MHz Pitch Size: 1 mm Number of Elements: 8 Elevation: 9 mm	S 4922104376	Mark on the probe 104376	
	PA-4M16E0.5P - LINEAR ARRAY Frequency: 4 MHz Pitch Size: 0.5 mm Number of Elements: 16 Elevation: 9 mm	S 4922104377	Mark on the probe 104377	
	VKPA-8/16 - 36° wedge (55° central angle for shear wave in low carbon steel) for S 4922104376 and S 4922104377 probes	S 4922104378	Suitable for flat surfaces and curved surfaces with OD ≥ 1000 mm  Linear array probes equipped with that wedge are defined in the instrument database as □ 104378W36 □ 104377W36	
	VKPA-8/16 CU XXX - 36° wedge (55° central angle for shear wave in low carbon steel) - axially contoured for XXX mm OD /// for S 4922104376 and S 4922104377 probes	S 4922104378 CU XXX	Suitable for OD < 1000 mm  Linear array probes equipped with that wedge are defined in the instrument database as  104378W36CUxxx 104377W36 CUxxx Whereas xxx is OD expressed in mm	
	PA-5M32E0.5P - LINEAR ARRAY Frequency: 5 MHz Pitch Size: 0.5 mm Number of Elements: 32 Width (Elevation): 10 mm	S 4922104379	Mark on the probe 104379	
	PA-5M16E1P - LINEAR ARRAY Frequency: 5 MHz Pitch Size: 1 mm Number of Elements: 16 Elevation: 10 mm	S4922105503	Mark on the probe 105503	
	PA-7.5M32E0.5P - LINEAR ARRAY Frequency: 7.5 MHz Pitch Size: 0.5 mm Number of Elements: 32 Elevation: 10 mm	S 4944109464	Mark on the probe 109464	
	VKPA-32 - 36° wedge (55° central angle for shear wave in low carbon steel) for S 4922104379, S4922105503, and S 4944109464 probes	S 4922104380	Suitable for flat surfaces and curved surfaces with OD ≥ 1000 mm  Linear array probes equipped with that wedge are defined in the instrument database as □ 104379W36 □ 105503W36 □ 109464W36	
	VKPA-32 CU XXX - 36° wedge (55° central angle for shear wave in low carbon steel) – axially contoured for XXX mm OD /// for S 4922104379, S4922105503, and S 4944109464 probes	S 4922104380 CU XXX	Suitable for OD < 1000 mm  Linear array probes equipped with that wedge are defined in the instrument database as  □ 104379W36CUxxx □ 105503W36CUxxx □ 109464W36CUxxx whereas xxx is OD expressed in mm	

#	ltem	Order Code (Part ##)	Note
	PA-2.25M16E1P - LINEAR ARRAY Frequency: 2.25 MHz Pitch Size: 1 mm Number of Elements: 16 Elevation: 13 mm	S 4922105504	Mark on the probe 105504
	VKPA-16/1 - 36° wedge (55° central angle for shear wave in low carbon steel) for S 4922105504 probe	S 4922104679	Suitable for flat surfaces and curved surfaces with OD ≥ 1000 mm Linear array probe equipped with that wedge are defined in the instrument database as □ 105504W36
	VKPA-16/1 CU XXX - 36° wedge (55° central angle for shear wave in low carbon steel) – axially contoured for XXX mm OD /// for S 4922105504 probe	S 4922104679 CU XXX	Suitable for OD < 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as  □ 105504W36CUxxx whereas xxx is OD expressed in mm
	PA-2.25M16E1.5P - LINEAR ARRAY Frequency: 2.25 MHz Pitch Size: 1.5 mm Number of Elements: 16 Elevation: 19 mm	S 4922105505	Mark on the probe 105505
	VKPA-16/1.5 - 36° wedge (55° central angle for shear wave in low carbon steel) for S 4922105505 probe	S 4922104680	Suitable for flat surfaces and curved surfaces with OD ≥ 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as  □ 105505W36
	VKPA-16/1.5 CU XXX - 36° wedge (55° central angle for shear wave in low carbon steel) – axially contoured for XXX mm OD /// for S 4922105505 probe	S 4922104680 CU XXX	Suitable for OD < 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as  □ 105505W36CUxxx whereas xxx is OD expressed in mm
	PA-1.5M16E1P - LINEAR ARRAY Frequency: 1.5 MHz Pitch Size: 1 mm Number of Elements: 16 Elevation: 12 mm	S 4922107553	Mark on the probe 107553
	VPKA-38-16-1-21 - 38° wedge (59° central angle for shear wave in low carbon steel) for S 4922107553 probe	S 4944262021	Suitable for flat surfaces and curved surfaces with OD ≥ 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as  □ 107553W39-21
	VPKA-38-16-1-12 - 38° wedge (59° central angle for shear wave in low carbon steel) for S 4922107553 probe	S 4944262012	Suitable for flat surfaces and curved surfaces with OD ≥ 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as □ 107553W39-12
	VPKA-38-16-1-21 CU XXX - 38° wedge (59° central angle for shear wave in low carbon steel) – axially contoured for XXX mm OD /// for S 4922107553 probe	S 4944262021 CU XXX	Suitable for OD < 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as  □ 107553W39-21CUxxx whereas xxx is OD expressed in mm
	VPKA-38-16-1-12 CU XXX - 38° wedge (59° central angle for shear wave in low carbon steel) – axially contoured for XXX mm OD /// for S 4922107553 probe	S 4944262012 CU XXX	Suitable for OD < 1000 mm  Linear array probe equipped with that wedge are defined in the instrument database as  □ 107553W39-12CUxxx whereas xxx is OD expressed in mm

# 5.3.2. General Rule for Keying In / Modifying Parameter

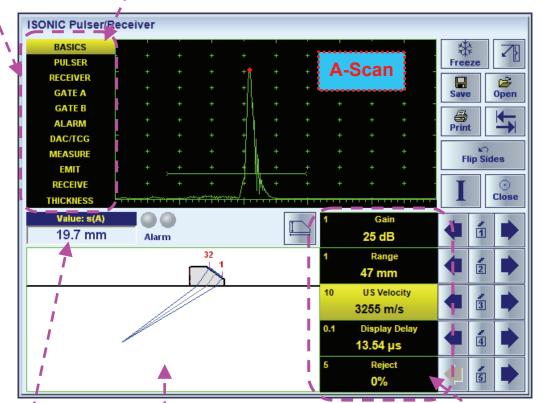


### 5.3.3. ISONIC PA Pulser Receiver - Wedged Linear Array Probes

### 5.3.3.1. Operating Surface

**ISONIC 2010** comprises 32 identical pulser receiver channels, which may be used in any combination to form ultrasonic beams in the material and receive echoes with use of PA probes. Manual control is implemented through main operating SW, which is similar to the operating surface of Sonontron NDT's flaw detectors working with conventional and TOFD probes

Main Menu Active Topic



Value Box – Digital Readout Graphical Presentation of PA
Probe, Aperture, Incidence
Angle, and Focal Point

Vertical bar – Submenu corresponding to the

The **Main Menu** consists of eleven topics; each topic is associated with corresponding **submenu** appearing as vertical bar showing names for five parameters or modes of operation, their current settings and current value of increment/decrement for a parameter. The active topic is highlighted. To select a topic click on its

name or on or press

To modify parameter or mode within the active topic proceed according to paragraph 5.3.2 of this Operating Manual

### 5.3.3.2. Sub Menu BASICS



All settings controllable through **BASICS** sub menu are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes



### **Gain and Range**

Modifying of **Gain** and **Range** settings is also possible through a number of other submenus

### **US Velocity**

Like in regular ultrasonic flaw detectors (conventional modality) proper **US Velocity** setting is important for correct:

- A-Scan time base setting
- Automatic measurements of reflector coordinates

Whilst implementing PA modality proper **US Velocity** setting is additionally important for correct forming of focal laws for the emitting and receiving signals. Hence **US Velocity** to be keyed in precisely for the desired type of wave to be generated in the material and for the expectedly received signals

### **Display Delay**

**Display Delay** may be controlled manually as in the regular ultrasonic flaw detector. However **Probe Delay** of PA probe is depending on plenty of factors such as emitting and receiving aperture and focal law to be implemented – refer to paragraphs 5.3.3.9, 5.3.3.10, and 5.3.3.11 of this Operating Manual. And for practical use very often it is important to equalize **Display Delay** and **Probe Delay** so start point of the A-Scan will correspond to the material surface. To activate / deactivate automatic performing of such equalizing (**Surface** 

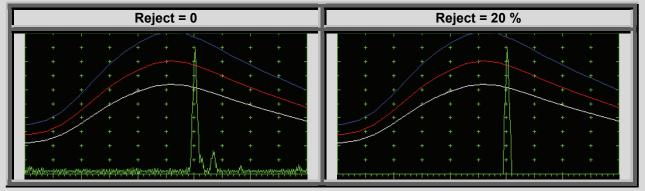




then click on  $\square$  or press  $\uparrow$ ,  $\longrightarrow$ ,  $\longleftarrow$ ,  $\downarrow$  then click on  $\square$  or press  $\square$  or press  $\square$  or Display Delay

### Reject

- Signals below Reject level (small signals) are suppressed
- Signals exceeding Reject level (large signals) are presented on the A-Scan without affecting their original height
- Part of large signal wave form below Reject level is suppressed



- Reject level may be applied to rectified signals only (Display Modes Full, NegHalf and PosHalf refer to paragraph 5.3.3.4 of this Operating Manual)
- Reject setup is also possible through a number of other submenus following the same rules as above

### 5.3.3.3. Sub Menu PULSER



All settings controllable through **PULSER** sub menu are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes



### **Pulser Modes**

There are two Pulser Modes available:

- ♦ **SINGLE** for that mode emitting and receiving aperture within entire PA probe are fully matching; focal point, incidence angle, and type of wave for the receiving and emitting aperture are identical and controlled synchronously
- DUAL for that mode emitting and receiving aperture within entire PA probe may be either fully matching or fully mismatching or partially matching; focal point, incidence angle, and type of wave are controlled separately

Refer to paragraphs 5.3.3.4 of this Operating Manual

### Pulse Width

- ◆ Pulse Width (Duration of Half Wave of Bipolar Square Wave Initial Pulse) is tunable between 50 ns to 600 ns in 5 ns steps
- Durations of positive and negative half wave of the initial pulse are varying synchronously
- ♦ Attempt to decrease **Pulse Width** below 50 ns switches initial pulse OFF and channel may be used then as receiver only

### **Firing Level**

There are 12 grades (1 through 12) for setting **Firing Level –** amplitude of initial pulse is controlled from 100 V peak to peak (**Firing Level = 1**) to 300 V peak to peak (**Firing Level = 12**)

### **PRF**

PRF is indicated for single pulsing / receiving cycle (single focal law)

### 5.3.3.4. Sub Menus EMIT, RECEIVE, and THICKNESS

### 5.3.3.4.1. Definitions

Emitting Aperture – quantity of elements of linear array probe involved into emitting of ultrasonic wave

Receiving Aperture – quantity of elements of linear array probe involved into receiving of ultrasonic signals

**Start** – number of the first element of the emitting / receiving aperture

Focal Distance – material travel distance between incidence point and focal point

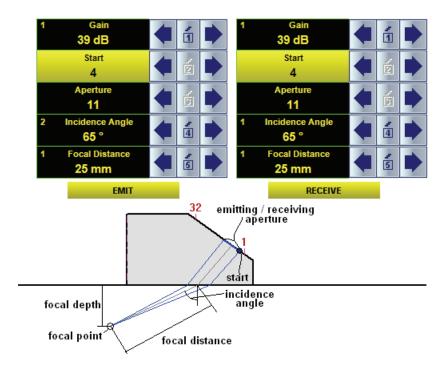
Focal Depth – depth of the focal point measured relatively contact surface of the material

Ultrasonic wave in the material is formed through superimposing of waves generated by all elements of the emitting aperture. The incidence angle and focal distance (depth) for the emitted ultrasonic wave are controlled electronically through phasing of initial pulses generated by the instrument on the elements of emitting aperture

Every element of the receiving aperture receives ultrasonic pulses from the material independently on others and converts them into electrical signals. Electrical signals from all elements of the receiving aperture are gained and digitized independently on each other then superimposed mathematically with use of digital phasing providing control of incidence angle and focal distance (depth) for the superimposed signal

### 5.3.3.4.2. Pulser Mode = SINGLE - Full Matching of Emitting and Receiving Aperture

For **Pulser Mode = SINGLE** emitting and receiving aperture within entire PA probe are fully matching; focal point, incidence angle, and type of wave for the receiving and emitting aperture are identical and controlled synchronously

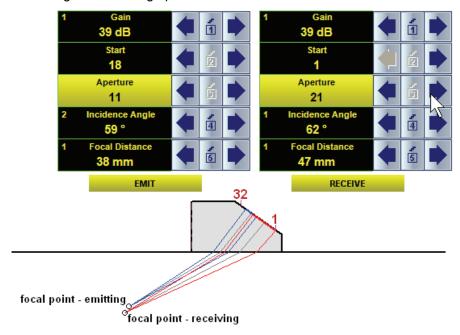


### 5.3.3.4.3. Pulser Mode = DUAL - Partial Matching of Emitting and Receiving Aperture

For **Pulser Mode = DUAL** emitting and receiving aperture within entire PA probe may be:

- fully matching
- fully mismatching
- partially matching

For all above the focal point, incidence angle, and type of wave are controlled separately separately from each other for the emitting and receiving aperture



### 5.3.3.4.4. Material Thickness

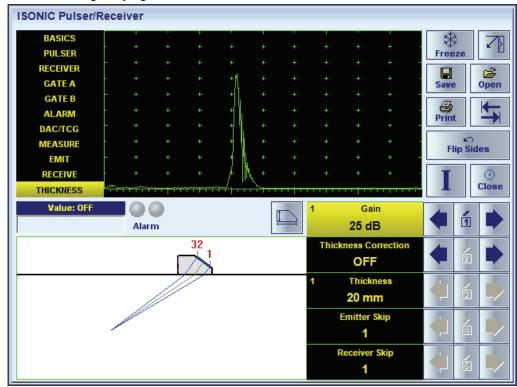
The are two modes of pulsing / receiving – with (**Thickness Correction = ON**) and without (**Thickness Correction = OFF**) considering thickness of the material

Thickness Correction = OFF	Thickness Correction = ON		
Parameter of focusing is <b>Focal Distance</b> : For the given <b>Focal Distance</b> varying of incidence angle will cause varying of <b>Focal Depth</b> – refer to paragraph 5.3.3.4.1 of this Operating Manual	Parameter of focusing is <b>Focal Depth</b> : For the given <b>Focal Depth</b> varying of incidence angle will cause varying of <b>Focal Distance</b> – refer to paragraph 5.3.3.4.1 of this Operating Manual; i.e. focusing is performed along horizontal line parallel to the contact surface of the material		
Imaging of the ultrasonic beam is implemented as for semi-finite space, the reflections from the walls are ignored	Imaging of the ultrasonic beam is implemented through considering of <b>Skips</b> , <b>Incidence Angle</b> , and material <b>Thickness</b>		

### Thickness Correction = OFF

Parameters Thickness, Emitter Skip, Receiver Skip ignored

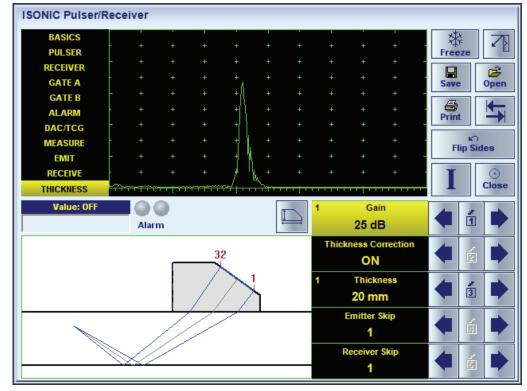
Focusing is defined through keying in Focal Distance



### **Thickness Correction = ON**

Parameters Thickness, Emitter Skip, Receiver Skip are considered

Focusing is defined through keying in Focal Distance

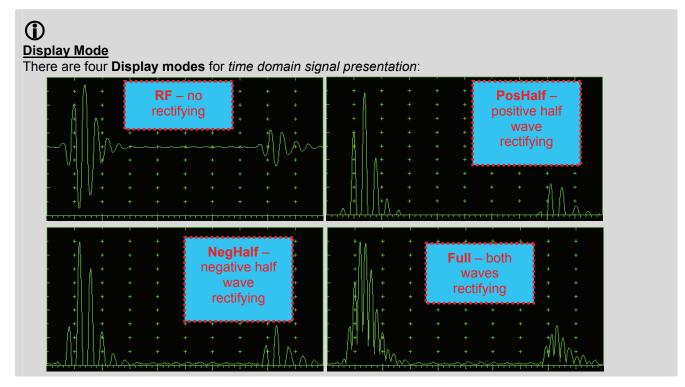


To modify the desired setting (**Thickness Correction**, **Thickness**, **Emitter Skip**, **Receiver Skip**) proceed according to paragraph 5.3.2 of this Operating Manual

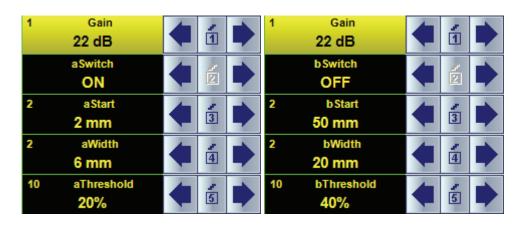
### 5.3.3.5. Sub Menu RECEIVER



All settings controllable through **RECEIVER** sub menu are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes



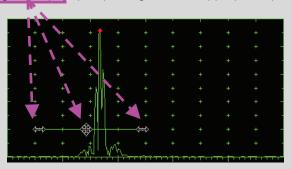
### 5.3.3.6. Sub Menus GATE A and GATE B



All settings controllable through **GATE A** and **GATE A** sub menus are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes

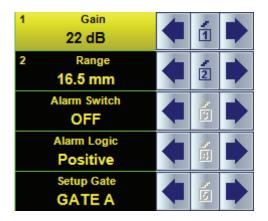


- aStart setup is also possible through a number of other submenus following the same rules as above
- Counting of aStart value starts after completing count of Probe Delay refer to paragraphs 5.2.12 and 5.2.13 of this Operating Manual
- ◆ Counting of **bStart** value starts after finishing of **Probe Delay** count (refer to paragraph 5.2.12 and 5.2.13 of this Operating Manual)
- ◆ Gates A and B may be manipulated through Drag and Drop provided that they are visible in the A-Scan area. Mouse pointer changes shape upon placing it above appropriate part of the gate

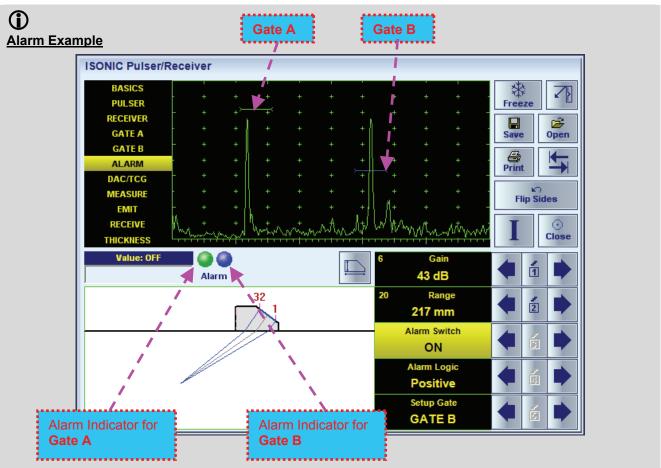


To control gate press and hold left mouse button or touch screen with stylus the and drag and drop through releasing of left mouse button or touch screen stylus

### 5.3.3.7. Sub Menu ALARM



All settings controllable through **ALARM** sub menu are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes



- ◆ There is a pulse matching with Gate A and not exceeding its threshold; the Alarm Logic setting for Gate A is Negative ⇒ Alarm Indicator for Gate A is active
- ◆ There is a pulse matching with Gate B and exceeding its threshold; the Alarm Logic setting for Gate B is Positive ⇒ Alarm Indicator for the Gate B is active

### 5.3.3.8. Sub Menu DAC/TCG



All settings controllable through **DAC/TCG** sub menu are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes

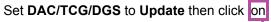


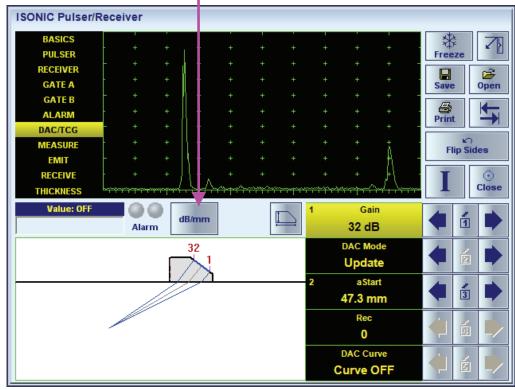
- ◆ There are four possible modes for **DAC/TCG**:
  - There are four possible modes for **DAC/TCG**:
    - OFF DAC Curve switches automatically to OFF while in OFF
    - **DAC** available if quantity of stored echoes is 2 (two) or more. **DAC Curve** switches automatically to **ON** while in **DAC** mode. Both experimental and theoretical methods for creating **DAC** are available
    - TCG available if quantity of stored echoes is 2 (two) or more. DAC Curve switches automatically to OFF while in TCG mode
    - Update allows to create/update new/existing DAC. Update of existing DAC performed through erasing of a number of sequentially recorded echoes, starting from the latest one, and/or recording of new echoes. The maximal number of echoes recorded into the one DAC is 40 (forty). DAC Curve switches automatically to ON if the number of recorded echoes is 2 (two) or more and switches automatically to OFF if number of recorded echoes is less than 2 (two) while in Update mode
- ♦ It is possible to Create / Modify / Activate DAC and TCG for all Display modes (RF, Full, Negative, and Positive)
- ◆ To create / modify **DAC/TCG** refer to paragraph 5.3.3.8 of this Operating Manual

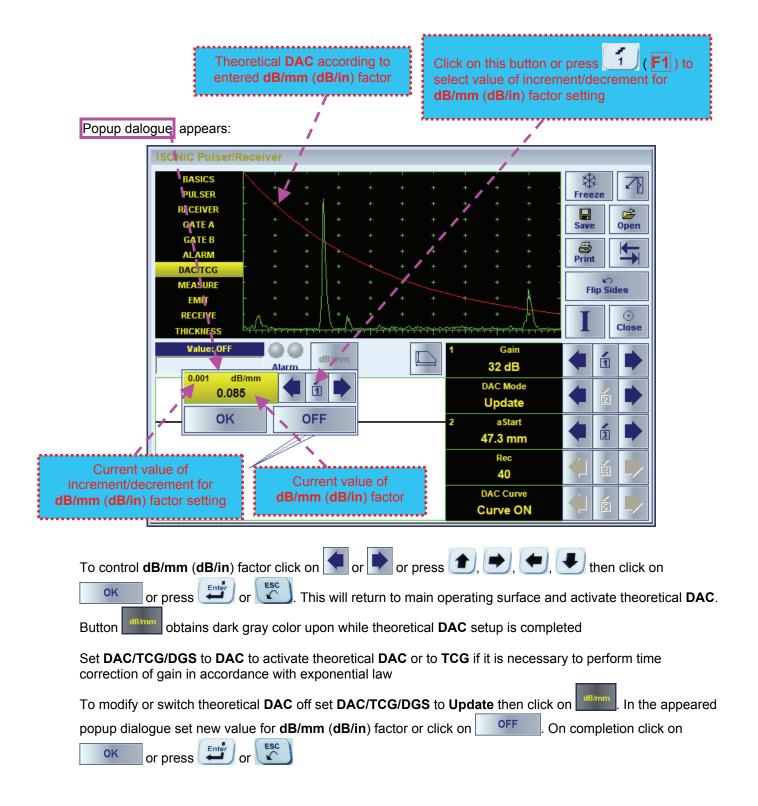
### 5.3.3.9. Create / Modify DAC

### 5.3.3.9.1 Theoretical DAC: dB/mm (dB/in)

Theoretical **DAC** represents exponential law for distance amplitude curve determined by **dB/mm** (**dB/in**) factor applied to pure material travel distance. The start point of **DAC** is contact surface and at that point DAC starts at 100% of A-Scan height. Theoretical **DAC** count starts immediately upon completion of **Probe Delay** count – refer to paragraphs 5.3.3.9 of this Operating Manual



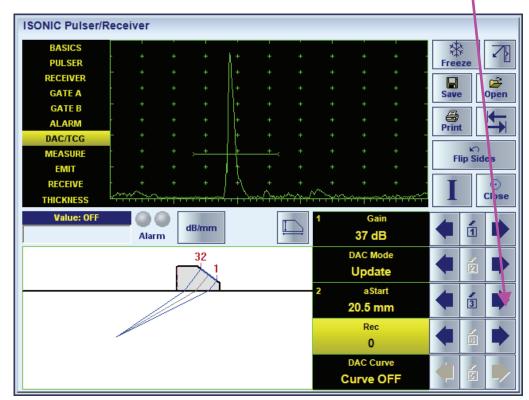




### 5.3.3.9.2 Experimental DAC: Recording Signals From Variously Located Reflectors

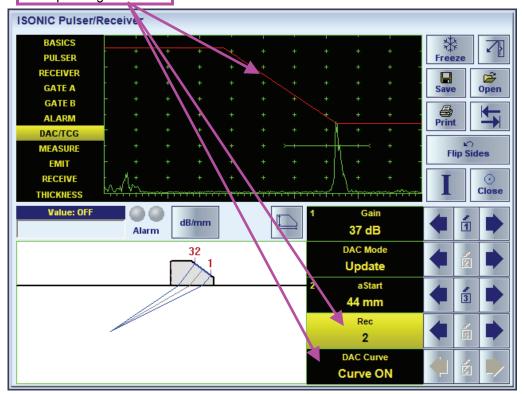
Prior to building experimental **DAC** switch theoretical **DAC** off and **Gate A** on. Set **DAC/TCG** to **Update**. Place probe onto **DAC** calibration block and maximize echo from the reflector closest to the probe (first

echo) then place **Gate A** over received signal and capture first *DAC* echo through click on or press



As a result the *first DAC echo* will be stored accompanied with corresponding indication:

Place probe onto DAC calibration block and maximize echo from next reflector then place **Gate A** over received signal and capture *next DAC echo*. As result next *DAC echo* will be stored causing appropriate modifying of corresponding indications



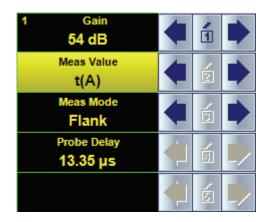


- ◆ The highest echo in the Gate A will be stored said echo may either exceed Gate A threshold level or not
- ◆ Stored echo must be below 100% of **A-Scan** height
- ♦ A total number of 40 echoes may be stored one by one by the same way as described above
- ♦ After creating a **DAC** (2 or more echoes stored) the **DAC** and / or **TCG** may be activated
- ♦ There are two styles of DAC indication in the DAC mode: Main Curve Only and Main Curve ± N dB,

where **N** may be setup between ±1 and ±14 dB with 1 dB increment:



### 5.3.3.10. Sub Menu MEASURE



All settings controllable through **MEASURE** sub menu are typical for conventional ultrasonic flaw detector and have the same meaning for the PA modality. To modify the desired setting proceed according to paragraph 5.3.2 of this Operating Manual. Also please refer to the below notes

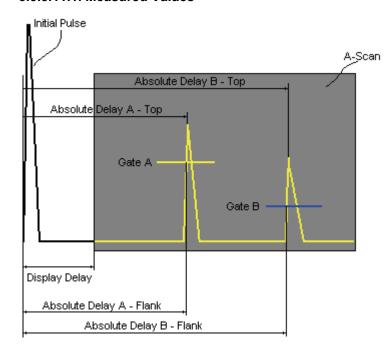


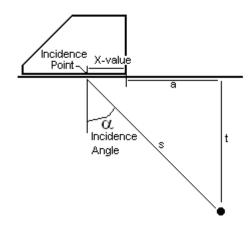
- Refer to paragraph 5.3.3.11 of this Operating Manual for information about values available for automatic measurement and indication in the **Value Box (Digital Readout)**
- There are four Measurement Modes possible:
  - ♦ Flank
  - ♦ Top
  - ♦ Flank-First
  - ♦ Top-First
- Probe Delay is determined by instrument automatically for all possible combinations of the following parameters:

Pulser Mode = SINGLE	Pulser Mode = DUAL
Aperture Start Incidence Angle Focal Distance (for Thickness Correction = ON) or Focal Depth (for Thickness Correction = OFF) USVelocity Wedge Velocity	EMIT Aperture EMIT Start EMIT Incidence Angle RECEIVE Aperture RECEIVE Start RECEIVE Incidence Angle Focal Distance (for Thickness Correction = ON) or Focal Depth (for Thickness Correction = OFF) USVelocity Wedge Velocity

### 5.3.3.11. A-Scan Based Measurements

### 5.3.3.11.1. Measured Values





Time of Flight - μs of an echo matching with Gate A / Gate B measured respectfully *Incidence Point*:

Material Travel Distance - mm or in of an echo matching with Gate A / Gate B measured respectfully *Incidence Point*:

$$s(A) = \frac{1}{2} \cdot T(A) \cdot US$$
 Velocity  
 $s(B) = \frac{1}{2} \cdot T(B) \cdot US$  Velocity

**Projection Distance** - mm or in of reflector returning an echo matching with **Gate A** / **Gate B**, measured respectfully front surface of the PA probe with taking into account migration of *Incident Point* and varying X-Value in accordance with varying *Incidence Angle*  $\alpha$ :

$$a(A) = s(A) \cdot sin(\alpha) - X$$
-value  
 $a(B) = s(B) \cdot sin(\alpha) - X$ -value

**Depth** - **mm** or **in** of reflector returning an echo matching with **Gate A** / **Gate B**:

$$t(A) = s(A) \cdot cos(\alpha)$$
  
 $t(B) = s(B) \cdot cos(\alpha)$ 

$$\Delta T = T(B) - T(A)$$

Value 10: Δs - mm or in:

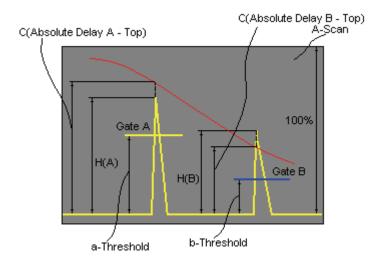
$$\Delta s = s(B) - s(A)$$

Value 11: ∆a - mm or in:

$$\Delta a = a(B) - a(A)$$

Value 12: At - mm or in:

$$\Delta t = t(B) - t(A)$$



Value 13: H(A) / Value 14: H(B)

Amplitude - % of A-Scan height of an echo matching with Gate A / Gate B

Value 15: V(A) / Value 16: V(B)

Amplitude - dB of an echo matching with Gate A / Gate B with respect to aThreshold:

$$V(A) = 20 \cdot log_{10} (H(A) / aThreshold)$$

$$V(B) = 20 \cdot log_{10} (H(B) / bThreshold)$$

Value 17: ΔV - dB:

$$\Delta V = V(B) - V(A)$$

Value 18:  $\Delta VC(A)$  ( dB to DAC ) – dB:

 $\Delta VC(A) = 20 \cdot log_{10} (H(A) / C (Absolute Delay A_Top))$ 

Value 19:  $\Delta VC(B)$  ( dB to DAC ) – dB:

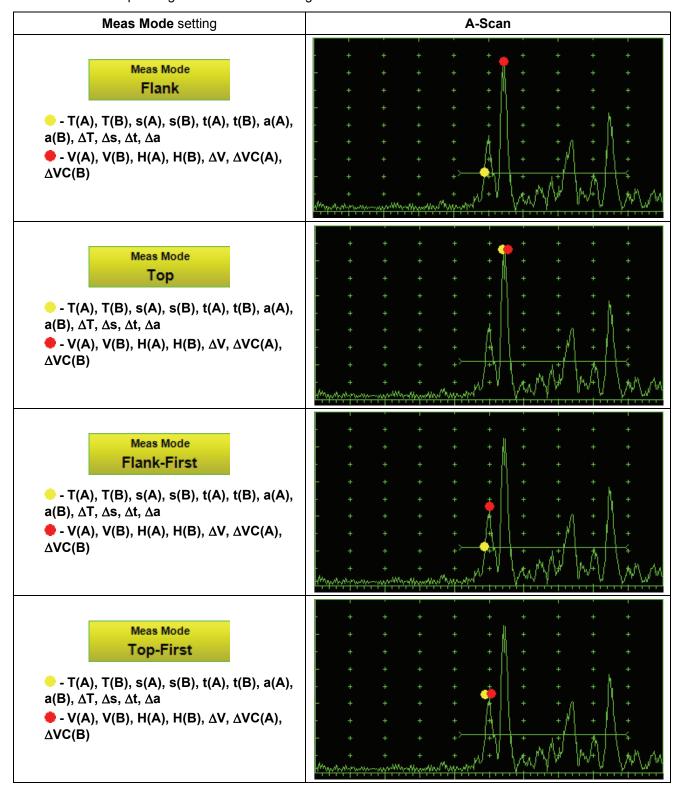
 $\Delta VC(B) = 20 \cdot log_{10} (H(B) / C (Absolute Delay B_Top))$ 



- To proceed the corresponding Gate or both Gates to be active
- ♦ ΔVC(A) (dB to DAC) measurements require active DAC
- ◆ Amplitude measurements of echoes may be performed provided their heights don't exceed 130% of A-Scan height
- ♦ For 2 and more echoes matching with the Gate refer to paragraph 5.3. 3.11.2 of this Operating Manual

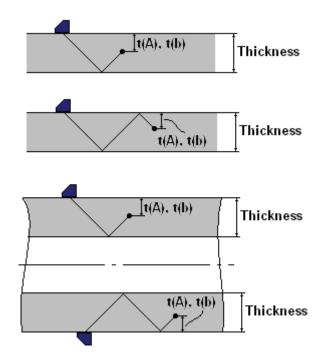
### 5.3.3.11.2. Measuring Modes

The table below represents distinguishing points on an **A-Scan**, which will be taken for automatic measurements depending on **Meas Mode** setting



### 5.3.3.11.3. Thickness Correction

The sketch below represents positioning of PA Probe on the plate and on the tube wall (longitudinal insonification).



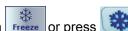
With reference to paragraph 5.3.3.4.4 of this Operating Manual on case of

### **Thickness Correction = ON**

for half skip, full skip, and multi skip insonification t(A), t(B) readings will represent actual depth of the targeted reflector provided the **Thickness** is entered properly

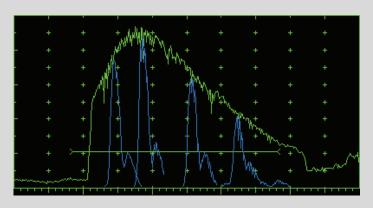
### 5.3.3.12. Freeze A-Scan

To freeze / freeze peak / unfreeze the **A-Scan** click on Freeze or press





Freeze Peak mode allows representing of Hilbert envelop for sequence of echoes obtained while manipulating probe over some reflector. This function may be useful for localization of echo maximum whilst in the A-Scan mode:



Freeze Peak mode may not be activated for RF signal presentation



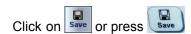
- at the upper left corner of **A-Scan** indicates that **Freeze Peak** mode is active
- The following operations are available for the frozen **A-Scan**:
  - Varying Gain in ± 6 dB range
  - Manipulating Gates A and B
  - Varying Alarm mode
  - Selecting parameter (Meas Value) for automatic measurements and obtaining corresponding digital readout
- Caption of appropriate button changes window upon freeze / freeze peak / unfreeze A-Scan:



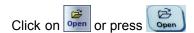




5	3	2	12	Savo	A-Scan	and Cali	ihration	Data	Into a	Fila
ວ.	. O.	.o.	ΊЭ.	Save	A-Scan	and Can	ibration	Dala	muo a	гие



### 5.3.3.14. Load A-Scan and Calibration Data From a File



### 5.3.3.15. Print A-Scan Settings List



### 5.3.3.16. Preview Current PA Probe in Use



### 5.3.3.17. Direction of Graphical Presentation

Click on Flip Sides

### 5.3.3.18. Activate Main Recording Menu

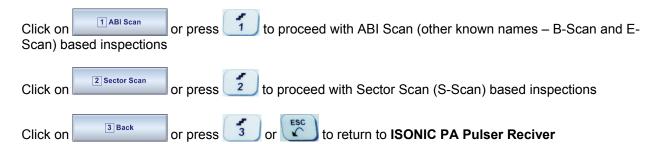


### 5.3.3.19. Return to Linear Array Probes Database



### 5.3.4. Main Recording Menu





### 5.3.4.1. ABI Scan (B-Scan, E-Scan)

Refer to paragraph 5.3.4.1 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

### 5.3.4.2. Sector Scan (S-Scan)

Refer to paragraph 5.3.4.2 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

# 5.4. Linear Array Probes With Straight Delay Line – Standard Modes of Operation

Use of linear array probe with straight delay line with **ISONIC 2010** is based on the same principles and controls as for wedged linear array probes. The following modes of functioning are possible:

- Selecting of PA probe from database, editing existing and adding new PA probe data, exportation and importation of PA probe data base to/from another instrument – refer to paragraph 5.3.1 of this Operating Manual
- ◆ PA Pulser Receiver refer to paragraph 5.3.3 of this Operating Manual. The difference is in the incidence angle manipulation range only: **–89...+89 deg** for linear array equipped / not equipped with delay line vs **35...80 deg** for wedged linear array
- Imaging and recording B-Scan cross sectional imaging and 3D data recording through linear scanning (C-Scan, Top, and Side Views) – refer to paragraph 5.3.4.1 of this Operating Manual. It is necessary just to note that incidence angle may be manipulated over wider range and dual mode of Pulsing / Receiving with partially of fully separated emitting and receiving aperture is allowed for linear array equipped / not equipped with delay line vs wedged linear array
- Imaging and recording Sector Scan cross sectional imaging and 3D data recording through linear scanning (C-Scan, Top, and Side Views) refer to paragraph 5.3.4.1 of this Operating Manual. It is necessary just to note that incidence angle may be manipulated over wider range and dual mode of Pulsing / Receiving with partially of fully separated emitting and receiving aperture is allowed for linear array equipped / not equipped with delay line vs wedged linear array

Typical PA probes and delay lines are listed below

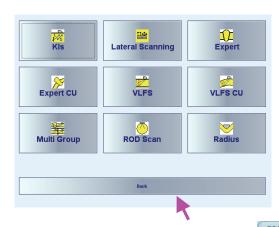
#	ltem	Order Code (Part ##)	Note
1	PA-2M8E1P - LINEAR ARRAY Frequency: 2 MHz Pitch Size: 1 mm Number of Elements: 8 Elevation: 9 mm	S 4922104376	Mark on the probe 104376
2	PA-4M16E0.5P - LINEAR ARRAY Frequency: 4 MHz Pitch Size: 0.5 mm Number of Elements: 16 Elevation: 9 mm	S 4922104377	Mark on the probe 104377
3	<b>V20PA-8/16</b> - 20 mm delay line for S 4922104376 and S 4922104377 probes	S 4922104681	
4	<b>V40PA-8/16</b> - 40 mm delay line for S 4922104376 and S 4922104377 probes	S 4922104700	
5	PA-5M32E0.5P - LINEAR ARRAY Frequency: 5 MHz Pitch Size: 0.5 mm Number of Elements: 32 Width (Elevation): 10 mm	S 4922104379	Mark on the probe 104379
6	PA-5M16E1P - LINEAR ARRAY Frequency: 5 MHz Pitch Size: 1 mm Number of Elements: 16 Elevation: 10 mm	S4922105503	Mark on the probe 105503
7	PA-7.5M32E0.5P - LINEAR ARRAY Frequency: 7.5 MHz Pitch Size: 0.5 mm Number of Elements: 32 Elevation: 10 mm	S 4944109464	Mark on the probe 109464
8	<b>V20PA-32</b> - 20 mm delay line for S 4922104379, S4922105503, and S 4944109464 probes	S 4922104682	
9	<b>V40PA-32</b> - 40 mm delay line for S 4922104379, S4922105503, and S 4944109464 probes	S 4922104701	

#	Item	Order Code (Part ##)	Note
	PA-2.25M16E1P - LINEAR ARRAY	S 4922105504	Mark on the probe 105504
	Frequency: 2.25 MHz		
	Pitch Size: 1 mm		
	Number of Elements: 16		
	Elevation: 13 mm		
11	V20PA-16/1 - 20 mm delay line for S 4922105504	S 4922104684	
	probe		
12	PA-2.25M16E1.5P - LINEAR ARRAY	S 4922105505	Mark on the probe 105505
	Frequency: 2.25 MHz		
	Pitch Size: 1.5 mm		
	Number of Elements: 16		
	Elevation: 19 mm		
13	<b>V20PA-16/1.5</b> - 20 mm delay line for S	S 4922104685	
	4922105505 probe		

### 5.5. Optional SW Packages and Utilities

### 5.5.1. Options Menu

Options menu screen is presented below



To run selected optional SW package click on it's icon. Click on or press to return to the menu of PA modalities modes

### 5.5.2. Linear Array PA Probes

### 5.5.2.1. K<sub>Is</sub> Optional SW Utility – Delta Technique

Refer to paragraph 5.5.2.1 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

### 5.5.2.2. Lateral Scanning Optional Inspection SW Package

Refer to paragraph 5.5.2.3 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

### 5.5.2.3. EXPERT – Optional Inspection SW Package For Welds

Refer to paragraph 5.5.2.4 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

# 5.5.2.4. EXPERT CU – Optional Inspection SW Package For Tubular Objects, Rods, and Welds

Refer to paragraph 5.5.2.5 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

### 5.5.2.5. VLFS – Optional Inspection SW Package

Refer to paragraph 5.5.2.6 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

### 5.5.2.6. VLFS CU – Optional Inspection SW Package

Refer to paragraph 5.5.2.7 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

### 5.5.2.7. Multi-Group – Optional Inspection SW Utility



Multi-Group optional SW package of ISONIC 2010 instrument allows implementation of several (up to 3) various insonification schemes simultaneously with use of differently configured groups of elements of wedged linear array probe. Each insonification scheme to be implemented with the same filter settings of ISONIC PA Pulser Receiver. Geometry settings (thickness, weld, curvature) if any, probe position, and USVelocity in the material as to be identical for all insonification schemes. Calibration for each insonification scheme to be performed in advance and the appropriate B-Scan / Sector-Scan files

either **TTGI** or not to be stored in advance in accordance with procedures described in the paragraphs 5.3.4.1, 5.3.4.2, 5.5.2.4 through 5.5.2.7 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>. Movie illustrating typical composing and implementation of multi-group insonification is available for viewing / download at <a href="http://www.sonotronndt.com/PDF/OM2009/MULTI\_GROUP.wmv">http://www.sonotronndt.com/PDF/OM2009/MULTI\_GROUP.wmv</a>

# 5.6. Viewing And Processing Of Recorded Files – PA Modality

Refer to paragraph 5.6 of **ISONIC 2009 UPA-Scope Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/PDF/OM2009/om2009.pdf">http://www.sonotronndt.com/PDF/OM2009/om2009.pdf</a>

6. Conventional PE and TOFD Modalities				

To operate conventional channel of **ISONIC 2010** in conventional PE and TOFD modalities refer to **ISONIC 2008 Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/pdf/om2008.pdf">http://www.sonotronndt.com/pdf/om2008.pdf</a>

The following chapters of ISONIC 2008 Operating Manual are applicable: 5, 6, 8, 9, and 10

# 7. Incremental Encoders

Various encoders for may be used with **ISONIC 2010**. For appropriate encoder data cable and connector pin-out contact

□ Nearest Sonotron NDT representative

OR

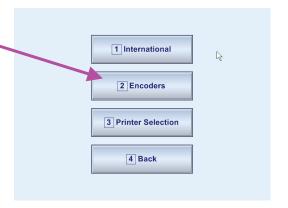
□ Directly to Sonotron NDT – e-mail to <u>support@sonotronndt.com</u> with subject ISONIC 2010 encoder connection



Improper cable out-coming from custom made encoder for proprietary inspection tasks may lead to warranty exempted damaging ISONIC 2010 instrument

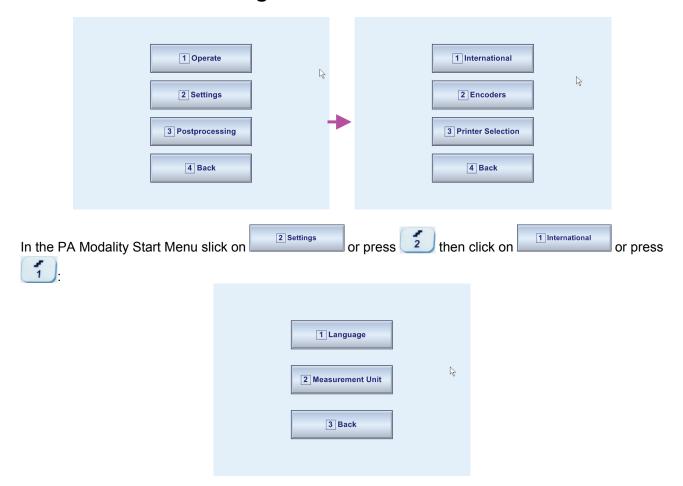
To calibrate / add to database / encoder click on

The proceed according to paragraph 8.4 of **ISONIC 2008 Operating Manual**. The latest version of this document is available for download at <a href="http://www.sonotronndt.com/pdf/om2008.pdf">http://www.sonotronndt.com/pdf/om2008.pdf</a>



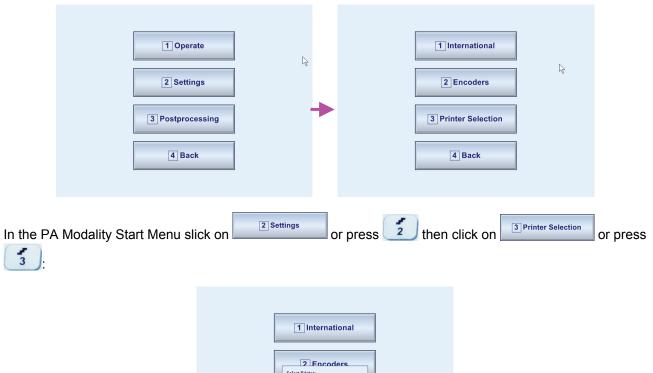
# 8. Miscellaneous

# 8.1. International Settings

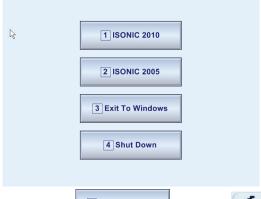


This will allow setting of dialogue language (English, Chinese, Portuguese, etc) and measuring units (metric or imperial)

# 8.2. Printer Selection



### 8.3. Exit to Windows



3 Exit To Windows to proceed with Windows XP In the ISONIC 2010 Start Screen click on or press Embedded settings of ISONIC 2010 instrument. To return to ISONIC 2010 Start Screen double click on icon located in the Windows Desktop



Exit to Windows is required for:

- Connection to network
  - Printing inspection results to network printer
  - Transferring data to / from remote PC
- □ Installing printer driver(s)
- Quasi-disk management

In order to prevent overloading of ISONIC 2010 quasi-disk and memory with data and non ISONIC 2010 SW that may affect instrument performance it's not allowed to install non ISONIC 2010 SW except drivers noted above. Affecting of instrument performance through installing on non ISONIC 2010 SW except drivers noted above is the warranty exemption damage

### 8.4. Connection to Network

To connect ISONIC 2010 to local area network use Ethernet connector (refer to paragraph 4.2 of this Operating Manual). Default factory settings are made for most typical connection to DHCP enabled network with obtaining IP automatically

### 8.5. External USB Devices

### 8.5.1. Mouse

Use one of 2 USB Connectors (refer to paragraph 4.2 of this Operating Manual). ISONIC 2010 founds and registers external USB mouse automatically through standard Windows routine. Microsoft optical mouse is recommended

### 8.5.2. Keyboard

Use one of 2 USB Connectors (refer to paragraph 4.2 of this Operating Manual). ISONIC 2010 founds and registers USB keyboard automatically through standard Windows routine. Microsoft keyboard is recommended

### 8.5.3. Memory Stick (Disk on Key)

Use one of 2 USB Connectors (refer to paragraph 4.2 of this Operating Manual). ISONIC 2010 running founds and registers USB memory stick (disk on key) automatically through standard Windows routine

### 8.5.4. Printer

Use one of 2 USB Connectors (refer to paragraph 4.2 of this Operating Manual). Preliminary driver setup is required. To install driver use network connection or USB memory stick (disk on key)

### 8.6. External VGA screen / VGA projector

Connect to appropriate connector (refer to paragraph 4.2 of this Operating Manual) while at least one of 2 devices either **ISONIC 2010** or external screen / projector is switched OFF then switch on one or both devices

# 8.7. SW Upgrade

Refer to http://www.sonotronndt.com/support.htm in the Internet

# 8.8. Charging Battery

Battery of **ISONIC 2010** may be charged while disconnected from the unit. The special charger is required (refer to Chapter 3 of this Operating Manual). Connect charger to the battery as it is shown below



There is **Charge** LED on the charger. While charging the battery this LED emits solid light. **Charge** LED starts flashing upon charge is completed



If a battery is new and almost completely discharged then "boiling" effect in the electrolyte may start earlier than battery is fully charged. In order to prevent battery charger stops on detecting boiling "boiling" effect:

- ☐ If temperature inside battery does not exceed 60°C deg limit then **Charge** LED starts flashing for such case it is necessary to disconnect charger from mains for few minutes and to connect it to mains again. The normal charging will continue
- ☐ If temperature inside battery exceeds 60°C deg limit then **Temp** LED starts flashing for such case it is necessary to disconnect charger from mains for at least 2 hours and to connect it to mains again. The normal charging will continue

After few charge / discharge cycles battery becomes "trained" and probability of "boiling" effect decreases to almost zero

### 8.9. Silicon Rubber Jacket

1. Establishing Image:



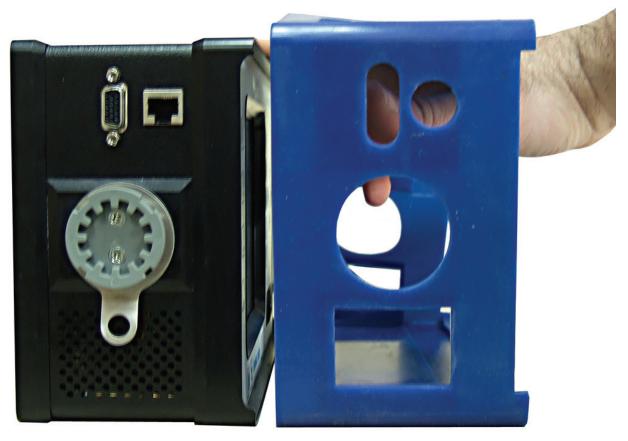
2. Push the gray buttons of the handle on both sides, and rotate the handle until it is released:



3. Lift-up and remove the handle:



4. Place the Silicone Rubber Jacket so that the holes match the ports of the ISONIC machine:



5. Slip the Silicone Rubber Jacket around the machine until it fits properly and covers all edges:



6. A view from the back:



7. Put the handle back in position and twist it until it locks in place:



8. DONE!

